

CONTENTS:

THEORY OF OPERATION
SCHEMATICS
ASSEMBLY PROCEDURE
ADDRESS SELECTION CHART
BAUD RATE SELECTION CHART

© MITS, Inc., 1975

PRINTED IN U.S.A.



the UART (I.C."M" of the 80-SIOB) and carefully adjust R29 to the voltage noted in Step 1, about 2.5 volts DC. This adjusts the demodulator to the speed of the tape being played. If you recorded and played the tape on the same recorder, then it is adjusted to record and play at that tape speed.

If you have to make this adjustment to play a tape from a different recorder (i.e. the Basic type), it will work only for tapes recorded at that different speed.

It should be readjusted for tapes being recorded and played on the same recorder such as the C load and C save functions.

STEP 4:To adjust the two filter pots, R9 and R13, play the tape with the output test program recorded on it and measure point "TP" on the modem board (pin 6 of IC "B") with the voltmeter on a low voltage A.C. range (10-15 volts.)

The voltage measured with the amplifiers clipping should be about 5 v RMS. Reduce the recorder volume until the volumeter reads 2 or 3 volts RMS and adjust R9

and R13 for maximum reading. Reduce the volume again, if necessary, to keep the reading below 4 volts RIS. Go back and adjust again to get maximum peak. Note that this is not a critical adjustment. Turn the volume back up to man, and go back and recheck the adjustment in step 3.

This completes alignment of the S8-ACR. If it requires readjustment to play data recorded on another machine, do steps 2 and 3. The MITS Altair Basic cassette has the test recording on the beginning of the back side. If you are using the Basic cassette, be sure your 83-ACR is wired for 300 Baud and address 6 and 7.

*****88-ACR ERRATA SHEET****

DUE TO CHANGES IN THE PC BOARD CONSTRUCTION, THE ASSEMBLY OF THE 88-ACR MODEM BOARD MUST BE ALTERED ACCORDING TO THE FOLLOWING INFORMATION.

PAGE 3: IC E, listed as a 74L93 will be substituted with a 7493.

PAGE 6: The instructions for installing the trim pots should be followed with the exception that they will now be installed on the back (non-silk-screened) side of the PC board.

 $\overline{ ext{PAGE 16}}$: There are two ground connections mentioned for the MODEM board. The board itself has three pads labeled GND. The two pads to be used are the second and third pads from the end with the "GND" label.

PAGES 18 & 19: With the trim pots now mounted on the back side of the PC board, the mating of the two boards must be altered. The spacers now used to separate the boards will be .7 inch spacers. The screws themselves will be 1 1/2 inch screws.

Mount the boards themselves in the same manner shown in the drawing; except, the trim pots will be pointing towards the other board. When correctly oriented, the component sides of the two board will be on the outside edges, the back (non-silk-screened) sides of the boards will be towards each other.

ERRATA SHEET: The errata sheet contained in the manual should be followed with the following exceptions. The 500uf capacitor should be connected with the same orientation, and to the same points as shown in the drawing; but, it should be mounted on the back side of the board as with the trim pots.

Also, plastic spacers will now be added to all three of the screws instead of just one as indicated. Place all three onto the screws in the same manner as called for by the sheet instructions.

THE TEST PROGRAMS ARE TO BE CHANGED AS FOLLOWS:

OUTPUT TEST PROGRAM

Address Location:	Change	Code To:		
20	1		006	
20	2		007	X
20	3		000	001
20	4		332	
21	2		007	

(cont. on back)

INPUT TEST PROGRAM

Address	Location:		Change	Code	To:	
		001 002 003 004 010				006 017 000 332
		340 341 342 343 347				007 006 017 000 332 007

 $\frac{\text{PAGE 5: Resistor R50 should be changed from 220K-ohms to 22K-ohms,}}{\text{red-red-orange.}}$

Here is some information that we hope can be useful to 88-ACR owners.

First, ACR stands for Audio Cassetts Recording, a method using sudio frequencies to record digital information. However, you are not limited to using only cassetts recorders for data stan-

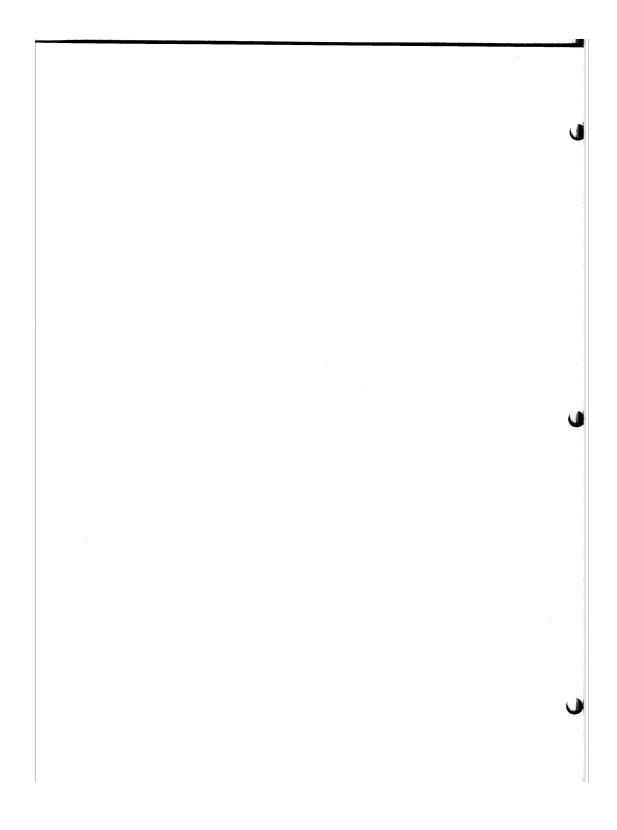
If the total error in transferring tapes between recorders is less than 20% there is no problem; if it is greater than 20% you will have to readjust the demodulator as described next.

To align your 88-ACR, we have found a new, easy, and accurate

88-ACR with 88-SIOB Parts List June 1975

88-ACR

CAG 1		BA	<u>G 6</u>		BAG	5	
2 uA741 1 XR210 1 74L02 1 74L20 1 7493 2 93L16	101056 101062 101072 101039 101030 101093	6 3 3 2 3	#4-40 nut #4-40 lockwashe #4-40x1 1/2"scru .15" spacer Mini jacks .7" spacer		4 1 1 1 BAG	6-32x1/2" screw #6 nut #6 lockwasher 6-32x1/4" screw	100918 100933 100942 100917
BAG 2 1 100 ohm 1/2w 2 470 ohm 1/2w 2 1K ohm 1/2w 2 1.5K ohm 1/2w	101924 101927 101928 101946	1	SCELLANEOUS PC board (modem) Assembly & Operator Manual Foil label set		13 6 1 2 MISO	6" wire 1 1/2" wire Edge connector Card guides CELLANEOUS	103017 103002 101864 101714
2 2.2K ohm 1/2w 1 3.3K ohm 1/2w 6 4.7K ohm 1/2w 1 8.2K ohm 1/2w	101945 102085 101930 102090		88-SIOB		1	PC board Manual	100132 101559
6 10K ohm 1/2w 1 15K ohm 1/2w 1 47K ohm 1/2w 2 100K ohm 1/2w 2 3.3 megohm 1/2w 1 500 ohm pot 25K ohm pot	101932 102083 101934 101936 102049 102025 102023	1 5 2 2 1 3	MC7805 74L00 74L02 74L02 74L30 74L30 74L193/93L66	101074 101080 101072 101073 101082 101087			
22K ohm 1/2w BAG 3	101933	1 4 1	9601 8T97 COM2502	101033 101040 101065			
4 470pF 1Kv 1 .001mF 1Kv 1 .01mF 16v 3 .033mF 16v 5 .1mF 10v 1 .15mF 100v 1 1mF 16v 1 4.7mF or 5mF 16v 1 30mF 16v	100316 100328 100305 100344 100348 100345 100306 100309 100369	BAG 1 2 1 1 BAG	12v zener 2.2K ohm 1/2w 7.5K ohm 1/2w 47 ohm 1/2w	100722 101945 101992 101922			
2 500mF 25v BAG 4	100318	2 10 1	30mF 10v elec .1mF 10v cer .001mF 10v cer	100369 100348 100359			
2 EN2907 1 CS4410-4438 2 IN914 1 12v zener(IN4742)	102804 102808 100705)100722	BAG 1 10 1	Connector Terminals Pin (10) 40 pin socket	101768 101769 101812 102106			
l 1/2" wire 8" red wire 20" shielded audio cable	103002 103041 103044	1	Heatsink (small)	101870			



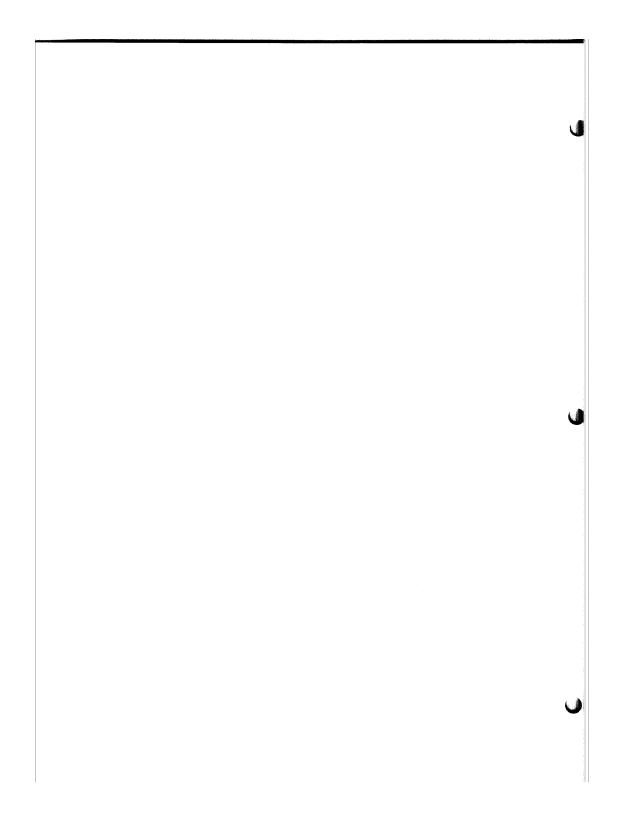


From: Customer Service

To: 88-ACR Kit Builders

Some 88-SIOB Boards have incorrect spacing on the Molex wafer connector mounting holes. If you have such a board, we recommend cutting your 10 pin Molex plug into a 4 and a 6 pin plug with a saw. The plastic removed by the saw will allow the connector to fit properly. The 4 pin section goes in the left hand position (spare, +5 & GND), and the 6 pin section goes in the right hand position (STSO-SRSI). If you damage the connector, notify us for a free replacement.

An alternative method is removing the pins from the plastic strip and soldering them in one by one, using the plastic shell for the mating connector as a guide.





AUDIO CASSETTE INTERFACE DOCUMENTATION

CONTENTS:

Introduction
SIO B Board Documentation
Modem Board Assembly Procedure
Modem Board Theory of Operation
Modem Board Schematic
Using the 88-ACR
Test Programs
Test Data

⊚MITS, Inc., 1975 PRINTED IN U.S.A.



P.O. BOX 8636 ALBUQUERQUE, NEW MEXICO 87108

88-ACR ASSEMBLY

The 88-ACR consists of two separate PC boards mated to each other to form a single unit. One of these is the ACR Modem Board and the other is the 88-SIO B, Serial TTL level I/O Board. The Modem board is used to key the signals into the correct audio tones and back, while the SIO B board is used to interface with the computer itself.

The first step in constructing the 88-ACR is assembling the SIO B Board. The following section is the standard SIO B Board documentation. Follow the Assembly Procedure and any pertaining errata according to the text, with the following exceptions:

PAGE 5---Resistor R1, listed as a 130-ohm resistor, should be substituted with a 47-ohm, yellow-violet-black, 1/2 Watt resistor for operation with the 88-ACR

PAGE 10---The BAUD rate should be set at 300 maximum

The jumpers POE, NDB1, NDB2 & NPB should go to +V and NSB should go to GND for 8-bit transmission

DO NOT PROCEED BEYOND THE INSTALLATION OF THE UART (IC M) ON PAGE 14, AT THIS POINT TURN TO THE ASSEMBLY PROCEDURE FOR THE MODEM BOARD.

THEORY of OPERATION

88-SIO SERIAL INTERFACE BOARD OPERATION

The serial interface board provides communication between the ALTAIR and any serial Input/Output devices. The board has two device code addresses which are hardware selectable by jumpers for any even numbered address from 0 to 376 (octal). The BAUD rate is also selectable, via jumpers, from 0 through 25,000 BAUD. This board also provides both hardware and software interrupt capability.

Device Select Logic

When the CPU executes an "OUT" or an "IN" instruction, it places the device address (provided with the instruction) on both the 8 lower order address bus lines and the 8 higher order address bus lines.

The 8 lower order address bus lines are fed to the select logic on the board, IC's H & J. If the address on the bus is equal to the address selected on the board, IC I pin 8 will go low, thus enabling IC J pins 3 & 6.

Depending on the state of AO (the least significant address bit), either the control channel or the data channel will be enabled. If AO is at a logic low level, IC J pin 4 will go high, thus enabling the control channel. If AO is at a logic high level, IC J pin 1 will go high, thus enabling the data channel. Of the two device addresses on the board, the control channel is always an even number and the data channel is always an odd number.

Control Channel

The control channel has two purposes: it is used to enable/disable the hardware interrupt capability for the Input or Output device, and to test the status of the Input/Output device.

After an "IN" instruction is executed with the control channel address, "SINP" goes high and IC J pin 4 is high thus causing IC G pin 3 to go low. This causes IC E pin 13 and IC D pin 8 to go low, thus enabling the Data In lines. (Note that IC D pin 12 is always high except during the initial power on clear, $\overline{\text{POC}}$.) $\overline{\text{SWE}}$ (Status Word Enable) is always enabled except when inputting data (see Data Channel explanation. This results in the status being inputted to the Data In lines and into the CPU accumulator.

The eight data bits are defined in the chart on the following page.

Bit Definition

DIC DC	- TITT CTON	
DATA BIT	LOGIC LOW LEVEL	LOGIC HIGH LEVEL
7	Output device Ready (X-mitter buffer empty) Also causes a hardware interrupt to occur if interrupt enabled*:	Not Ready
6	NOT USED	NOT USED
5	NOT USED	
4		Data Overflow (a new word of data has been recieved before the previous word was inputed to the accumulator)
3		Framming Error (data word has no valid stop bit)
2		Parity Error (recieved parity does not aggree with selected parity)
1	NOT USED	
0	Input device Ready Data is available for computer to input *	NOT READY

When an "OUT" instruction is executed with the control channel address, data bits 0 & 1 are gated through IC's E & A to the Input/Output interrupt flip-flops, IC B.

The chart below describes the result of setting these two bits.

DO	D1	OUTPUT INTERRUPT	INPUT INTERRUPT
low	1 ow	disabled	disabled
low	high	enabled	disabled
high	1ow	disabled	enabled
high	high	enabled	enabled

then execute an "OUT" instruction with the control channel address.

Data Channel

The data channel transfers the data between the device and the CPU.

An "OUT" instruction, accompanied by the data channel address (odd numbered address), will pull "SOUT" and IC J pin 1 high, causing IC G pin 11 to go low. As soon as the CPU has put the data from the accumulator onto the data out bus, \overline{PWR} goes low pulling IC S pin 4 low to strobe \overline{IDS} (Transmit Data Strobe) at pin 23 of IC M. This causes the parallel data on the bus to be loaded and then transmitted serially. Pin 4 of IC S also resets the output ready flip-flop (IC F-b) to clear the busy signal to the device.

An "IN" instruction with the data channel address will pull "SINP" and pin 1 of IC J high causing pin 8 of IC G to go low, thus enabling $\overline{\text{RDE}}$ (Recieved Data Enable) at pin 4 of IC M and the Data In lines (IC D pin 8). This also disables $\overline{\text{SWE}}$ at IC E pin 10. This puts the recieved data on the bus and the CPU strobes it into the accumulator during DBIN (Data Bus In). Pin 8 of IC G also resets the input ready flipflop (IC F-a) and the UART Data Available flip-flop, $\overline{\text{RDAV}}$ at pin 18 of IC M.

UART

The Universal Asynchronous Reciever-Transmitter (UART) provides the paralled to serial and serial to parallel data conversion necessary to interface a serial device with the parallel ALTAIR. It also has a status word for "handshake" and error checking.

Both the Reciever and the Transmitter require a clock input frequency that is 16 times the BAUD rate. This is accomplished with a 12 bit presetable counter (IC's P, Q & R) and a single shot (IC 0). If the frequency required is not found in the "BAUD RATE SELECTION CHART" included in this manual, use the formula below:

The maximum frequency is 400KHz. The maximum BAUD rate is (400K/16) 25,000 BAUD.

The UART (IC M) has several programable functions as described below.

UART PIN #	NAME	FUNCTION			
35	NPB	Eliminates p (see pin	arity b 39, POE	it from being t)	ransmitted when tied high
36	NSB			stop bit is tra stop bits are	
37 38	NDB2 NDB1	Defines the NDB2	number o	of data bits pe	r character as shown below:
		low	low	5	
		low	high	6	
		high	1ow	7	
		high	high	8	
39	POE	If NPB is ti or even as s	ed low, hown bel	POE defines who	ether parity will be odd
		<u>P0E</u>	<u>NPB</u>	PARITY	
		1ow	1 ow	odd	
		high	low	even	
		X	high	none	(X = don't care)

Interrupt

The serial board is provided with hardware interrupt capability. The pads on the board labeled "OUT", "IN" & "BH" are provided for interrupt control. These three pads represent the Output device, the Input device or BotH devices and are jumpered to one or more of the pads labeled "VI" and numbered 0 through 7 at the bottom of the board.

"VI" represents "Vectored Interrupt" and the numbered pads, 0 through 7, are the 8 interrupt lines which connect into the Vectored Interrupt Board (88-VI). The numbers 0 through 7 correspond to the 8 priority levels, with 0 being the lowest and 7 the highest priority.

You can assign the input device and the output device each a different priority, or you can assign both devices a single priority. If you do not have the 88-VI board, you can jumper one of the three pads ("OUT", "IN" & "BH") on one of your I/O boards to the processor input interrupt line.

The processor input interrupt line has a pad labeled "INT" on the board (see assembly manual). This will allow one level of interrupt to the processor. When the interrupt occurs, the processor will immediately jump to the location 70 (octal) and begin execution. Place your interrupt service routine in locations 70 through 77 (octal).

SERIAL I/O INTERFACE OPERATION

The $88-SIO\ A$ Board is a standard RS-232 level interface board.

The output, "TSO" is normally marking (a logic low level) which causes Q4 to turn on and the output signal, "STSO" is thus held positive (\pm 3v). The serial data pulses cause Q4 to turn on and off, shifting the signal from the O & \pm 2 volt TTL levels to \pm 3 and \pm 12 volt RS-232 levels respectively.

The incoming RS-232 signals (+3v & -12v) on "SRSI" cause Q3 to turn on and off. This shifts the signals to "RSI" to normal TTL levels (0v & +2v).

The <u>88-SIO B</u> Board is a standard <u>TTL</u> level interface board.

The incoming TTL serial data line, "SRSI", is buffered at IC U pins 9 & 10 to decrease the required input current to .5ma worst case.

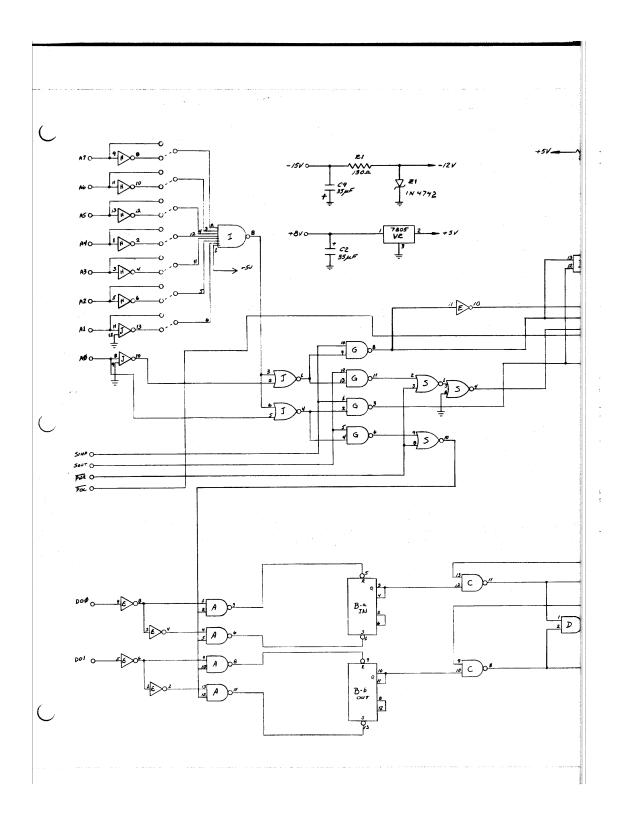
"TSO", the serial transmit data line, is buffered through IC U pins 6 & 7 to increase the drive capability to 20 TTL loads (approximately 48ma).

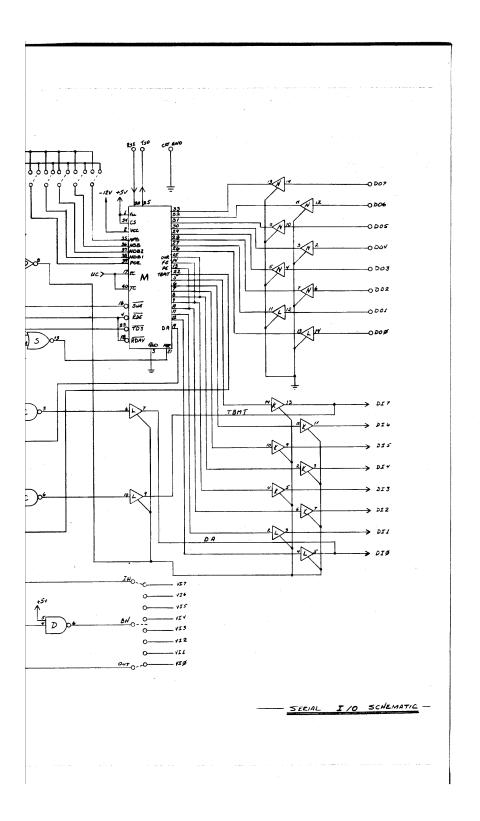
The <u>88-SIO C</u> Board is a standard <u>TTY</u> level interface board.

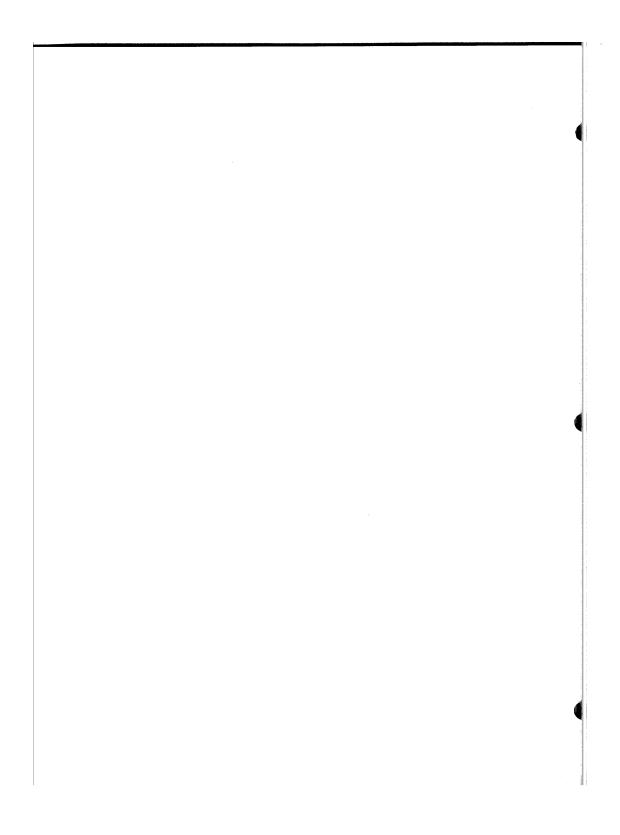
The two inputs, labeled "SRSI", are designed for connection to normally closed contacts (for a teletype, these are pins 3 & 4 on the teletype terminal block). This will normally pull IC U pin 9 low and pin 8 high, since diode DI is reverse biased. When the contacts open, IC U pin 9 is pulled to approximately 4 volts by the divider R5 & R6, and IC U pin 8 goes low.

The serial output from IC M, "TSO", is inverted through IC U pins 5 & 6 and fed to the base of Ql. "TSO" is normally high, pulling IC U pin 6 low to turn Ql on and allow current to flow from "STSO" through Ql and RlO to \pm 5volts. When "TSO" is low, Ql turns off and presents a high impedance to "STSO".

750>-







SERIAL I/O BOARD

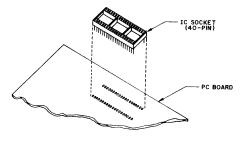
ASSEMBLY -----

**----PROCEDURE

8800 SERIAL I/O B BOARD ASSEMBLY

There are 19 integrated circuits (IC's) to be installed on the 8800 Serial I/O B Board. (88-SIOB) One of these, IC M, will be provided with a 40-pin IC socket. IC M itself should not be installed into the socket until the board is completely assembled.

 () Referring to the component layout, set the 40-pin IC socket included in your kit into place and secure it with a piece of masking tape. (see drawing below)



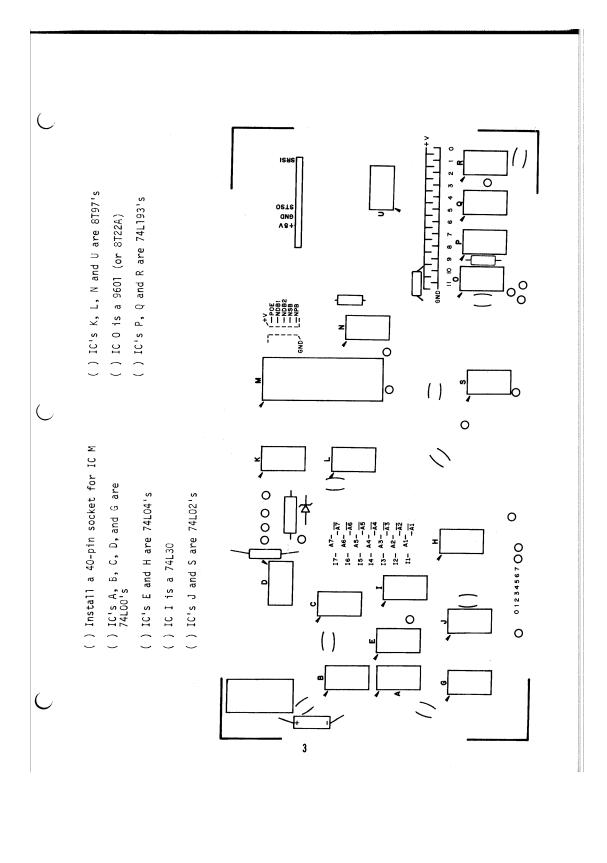
- () Turn the board over and solder each pin to the foil pattern on the back side of the board. Be sure to solder each pin and be careful not to leave any solder bridges.
- () Turn the board over again and remove the piece of masking tape.
- () Referring to the component layout, remove the IC with the correct part number from its holder. If there are any bent pins, straighten these using needle-nose pliers. Ensure that you choose the IC with the correct part number as you install each one.

 Orient the IC so that its notched end is towards the arrowhead printed on the board, and pin 1 of the IC corresponds with the arrowhead itself.

NOTE: If the IC does not have a notch on one end, refer to the IC Orientation Chart included with your manual for the identification of pin 1.

- () When you have the correct orientation, start the pins on one side of the IC into their respective holes on the silk-screened side of the PC board. DO NOT PUSH THE PINS IN ALL THE WAY. If you have difficulty getting the pins into the holes, use the tip of a small screwdriver to guide them.
- () Start the pins on the other side of the IC into their holes in the same manner. When all of the pins have been started, set the IC in place by gently rocking it back and forth until it rests as close as possible to the board. Make sure that the IC is perfectly straight and as close as possible to the board; then tape it in place with a piece of masking tape.
- () Turn the board over and solder each pin to the foil pattern on the back side of the board. Be sure to solder each pin and be careful not to leave any solder bridges.
- () Turn the board over again and remove the piece of masking tape.

Use the same procedure to install each of the IC's. Be sure that you have the correct part number and the correct orientation as you install each one.



Resistor Installation

There are 4 resistors to be mounted on the 8800 Serial I/O B Board.

NOTE: Resistors are color-coded according to their value. The resistors in your kit will have four or possibly five bands of color. The fourth band in both cases will be gold or silver, indicating the tolerance. In the following instructions we will be concerned only with the three bands of color to one side of the gold or silver band. Be sure to match these three bands of color with those called for in the instructions as you install each resistor.

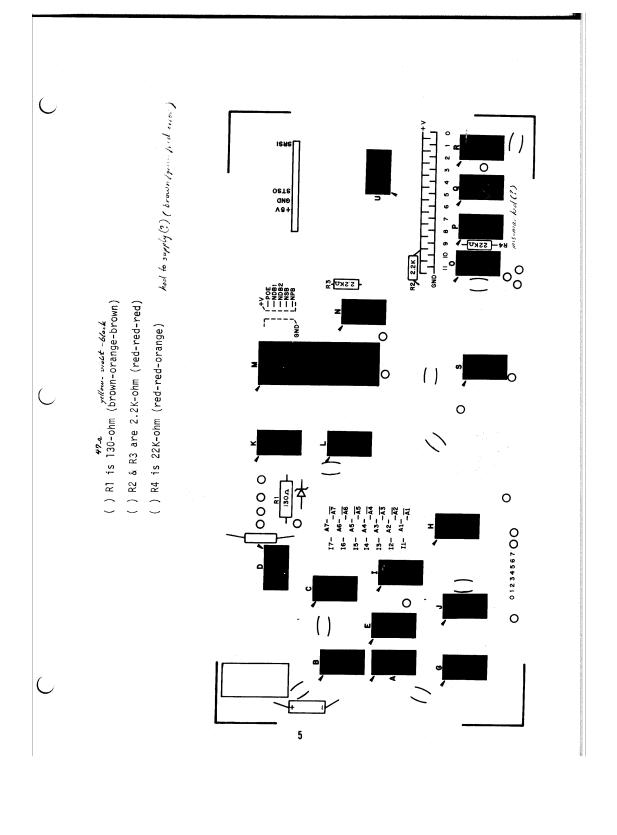
Using needle-nose pliers, bend the leads of the following resistors at right angles to match their respective holes on the PC board. (see component layout)

 $\frac{\text{NOTE}\colon}{\text{I/O}}$ All resistors on the 8800 Serial $\overline{\text{I/O}}$ B Board are either 1/4 or 1/2 Watt.

- () Install resistor R1 (130-ohm, brownorange-brown) into the correct holes on the silk-screened side of the PC board.
- Holding the resistor in place with one hand, turn the board over and bend the two leads slightly outward.
- () Solder the leads to the foil pattern on the back side of the board; then clip off any excess lead lengths.

Referring to the component layout, install the remaining resistors in the same manner. Be sure you have the correct color-coding for each one as you install them.

NOTE: Save all of the component leads that you clip off for use later in the assembly procedure.



Capacitor Installation

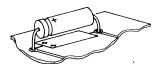
There are 9 ceramic disk capacitors and 2 electrolytic capacitors to be installed on the 8800 Serial I/O B Board.

Refer to the component layout and install the ceramic disk capacitors according to the following procedure.

- () Choose the capacitor with the correct value as called for in the instructions. Straighten the two leads as necessary and bend them to fit their respective holes on the PC board.
- () Insert the capacitor into the correct holes from the silk-screened side of the board. Push the capacitor down until the ceramic insulation almost touches the foil pattern.
- Holding the capacitor in place, turn the board over and bend the two leads slightly outward.
- Solder the two leads to the foil pattern on the back side of the board; then clip off any excess lead lengths.

Install all of the ceramic disk capacitors in this manner. Be sure that you have the correct value capacitor as you install each one.

The two electrolytic capacitors for the Serial I/O Board have polarity requirements which must be noted before installation. Those contained in your kit may have one or possibly two of three types of polarity markings. To determine the correct orientation, look for the following: (see drawing above right)



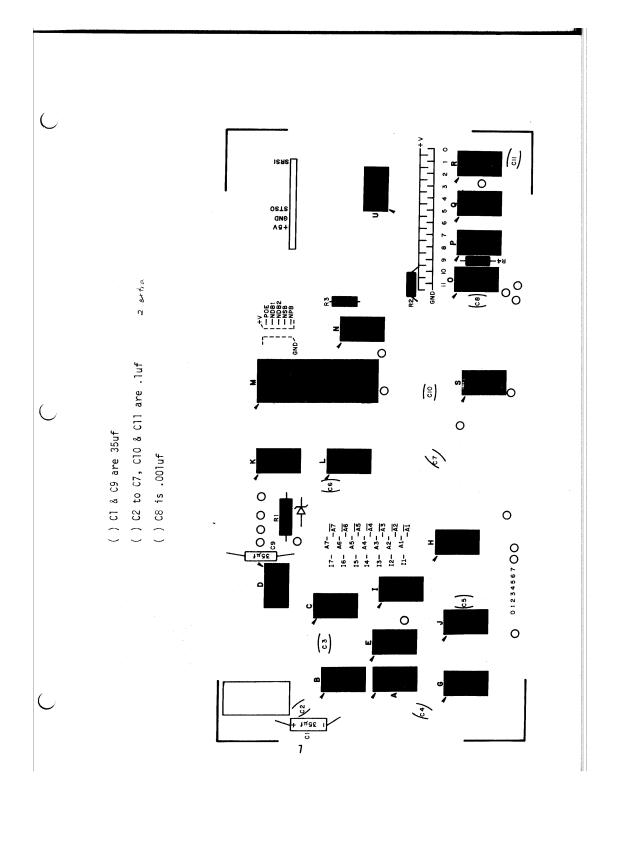
ELECTROLYTIC CAPACITOR



One type will have plus (+) signs on the positive end; another will have a band or a groove around the positive side in addition to the plus signs. The third type will have an arrow on it; in the tip of the arrow there is a negative (-) sign and the capacitor must be oriented so the arrow points to the negative polarity side

Referring to the component layout, install the electrolytic capacitors on the board.

- () Bend the two leads of the capacitor with the correct value at right angles to match their respective holes on the board. Insert the capacitor into the holes on the silk-screened side of the board. Be sure to align the positive polarity side with the "+" signs printed on the board.
- () Holding the capacitor in place, turn the board over and bend the two leads slightly outward. Solder the leads to the foil pattern and clip off any excess lead lengths.
- () Install the second electrolytic capacitor in the same manner.



Diode Installation

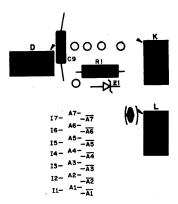
There is one 12-volt zener diode to be installed on the $8800\ Serial\ I/O\ B$ Board.

 ${\color{red} {NOTE}}:$ Diodes are marked with a band on one end indicating the cathode end. The diode <u>must be oriented</u> so that the end with the band is towards the band printed on the board when being installed.

- () Referring to the component layout, bend the leads of zener diode Z1 at right angles to match the correct holes on the board.
- () Insert the diode into the correct holes from the silk-screened side of the board. Turn the board over and bend the two leads slightly outward.
- () Solder the two leads to the foil pattern on the back side of the board; then clip off any excess lead lengths.

() Z1 is a 12-volt zener diode

 $\frac{\text{NOTE}}{\text{"12v"}}$ The 12-volt zener will be marked $\frac{\text{"12v"}}{\text{"12v"}}$ or 1N4742.



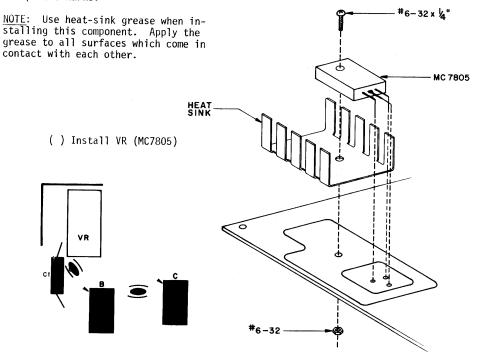
Voltage Regulator Installation

There is one MC7805 5-volt regulator to be installed on the $8800\ \mbox{Serial}$ I/O \mbox{B} Board.

- () Set the MC7805 in place on the board and align the mounting holes. (see drawing)
- Use a pencil to mark the point on each of the three leads where they line up with their respective holes on the board.
- () Use needle-nose pliers to bend each of the three leads at a right angle on the points where you made the pencil marks.

() Referring to the drawing, set the regulator and heat sink in place on the silk-screened side of the board. Use the smaller, 6 pronged, heat sink instead of the 8 pronged one shown in the drawing. Secure them as shown, holding the regulator in place as you tighten the nut.

- () Turn the board over and solder the three leads to the foil pattern on the back side of the board. Be sure not to leave any solder bridges.
- () Clip off any excess lead lengths.



Hardwire Connections

There are 30 hardwire connections, with one optional connection, to be made on the 8800 Serial I/O B Board.

The first five connections to be made are near IC M, towards the top right corner of the board. Make these connections using 1 inch wires. Make each connection by inserting the wire from the silk-screened side of the board and soldering it on the back side. Be sure to clip off any excess lead lengths.

- () Connect the pad labeled NSB according to the following information: NSB--to--GND = 1 stop bit NSB--to--+V = 2 stop bits
- () Connect the pads labeled POE and NPB according to the following information:

<u>NPB</u>	<u>POE</u>	1	MODE
GND	GND	odd	parity
GND	+7	even	parity
+ V	X	no	parity

(X = don't care)

NDB2

NSB GND

() Connect the pads labeled NDB1 and NDB2 according to the following information:

NDB1	NDB2	data bits/character
GND	GND	5
+٧	GND	6
GND	+V	7
+٧	+٧	8

 $\frac{\text{NOTE}\colon}{Q\ \&\ R}$ will not be used except with the 88-ACR interface. (see ACR assembly)

There are 6 jumper connections to be made on this board. Make these using 6 inch wires in the same manner as the previous connections with 1 inch wires.

- () Connect pad -V to pad -V
- () Connect pad 0 to pad 0
- () Connect pad I to pad I
- () Connect pad PC to pad PC
- () Connect pad C to pad C
- () Connect pad H to pad H

The connections for the address selection and the BAUD rate selection are made with component leads saved from earlier steps in the assembly procedure. Bend the leads as necessary to fit their respective holes on the board and insert them from the silk-screened side. Solder them on the back side of the board and clip off any excess lead lengths.

Refer to the I/O ADDRESS SELECTION CHART and the I/O BAUD RATE SELECTION CHART for the necessary information for making these selections.

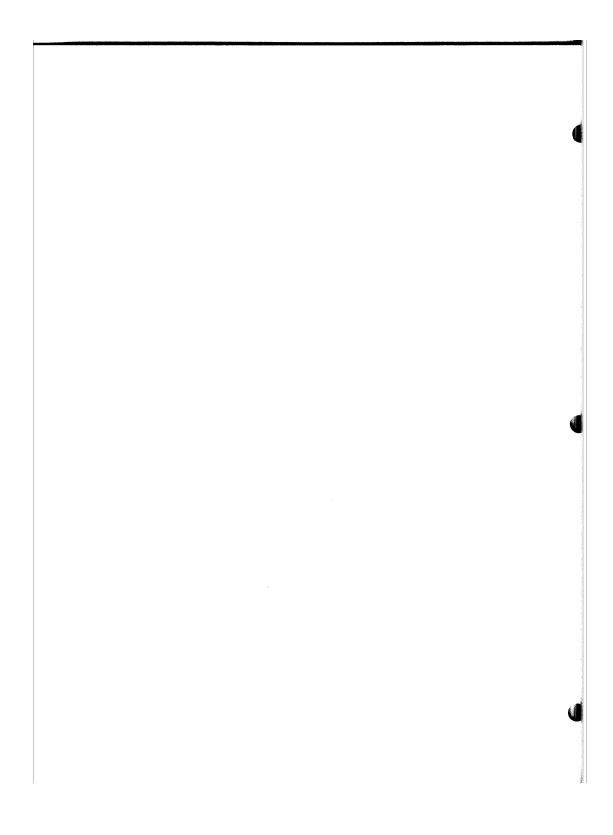
 $\frac{\text{NOTE}\colon}{\text{pads}}$ In the address selection, wire $\frac{1}{\text{pads}}$ Il through I7 to Al & AT through A7 & $\frac{1}{\text{A7}}$ as indicated in the chart to obtain the octal address listed in the left column.

Refer to the Theory of Operation manual for further explanations of these two functions.

SERIAL I/O BOARD ASSEMBLY MANUAL ERRATA

THE FOLLOWING INFORMATION IS IN REFERENCE TO THE "HARDWIRE CONNECTIONS" SECTION OF THE I/O MANUAL (Page 12 in the SIO A & C, Page 10 in the SIO B).

THERE ARE FIVE PADS TO BE OPTIONALLY CONNECTED TO EITHER GROUND OR +V. THE DESIGNATIONS PRINTED ON THE BOARD, POE, NDB1, NDB2, NSB AND NPB, REFER TO THE ENTIRE HORIZONTAL GROUP OF THREE PADS TO THE RIGHT OF IC M. THE PADS CLOSEST TO IC M ARE THE ONES TO BE CONNECTED TO EITHER THE SECOND VERTICAL GROUP OF FIVE PADS (GND) OR THE THIRD VERTICAL GROUP OF FIVE PADS (+V). THE POE, NDB1, NDB2, NSB AND NPB PADS THEMSELVES ARE THE FIVE PADS RUNNING VERTICALLY DIRECTLY NEXT TO IC M.



Vectored Interrupt

This is an optional function on the 8800 system, and need not be used at all. If it is to be used, it must be used in conjunction with the 88-VI vectored interrupt card. There is one exception to this which will be explained towards the end of this section.

The 8800 Serial I/O B Board has provisions for vectored interrupt hardwire connections. This provides the user with the option of selecting a priority level for the input device and the output device, or a single priority level for both. The vectored interrupt offers 8 levels of priority, 0 through 7, with 7 being the highest priority level.

There are three pads at the top of the board labeled "OUT", "IN" and "BH". There are eight pads at the bottom of the board numbered 0 through 7. The eight numbered pads correspond to the eight priority levels respectively.

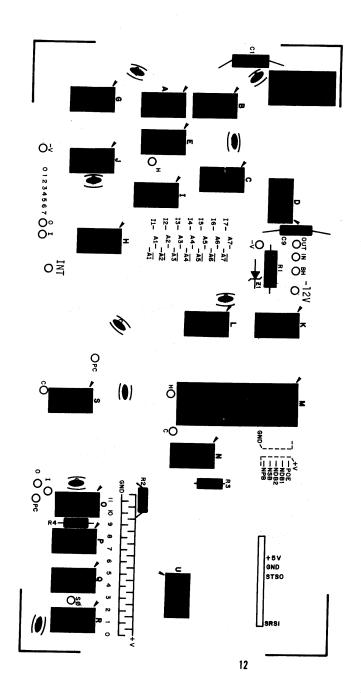
Use 6 inch wires to make these connections in the same manner as the previous jumper connections.

You may connect the "OUT" (output device) pad to some priority level, and the "IN" (input device) pad to some priority level; or you may connect the "BH" (both devices) pad to a desired priority level for both devices. If the "BH" pad is used to set the priority level, the "OUT" and "IN" pads should not be used.

 Connect the vectored interrupt priority level as desired per the information above. It is possible to obtain a <u>single</u> level of interrupt priority on this board without the necessity of the 88-VI vectored interrupt card.

This may be used only on one of the I/O cards in your system, and only one of the three pads ("OUT", "IN" and "BH") can be used to make the connection.

() For a single level of priority interrupt, connect a jumper wire between the pad near the bottom of the board labeled "INT" and the desired pad at the top of the board. Remember only one of the three pads "OUT", "IN" or "BH" may be used and only one I/O board may be connected in this manner.

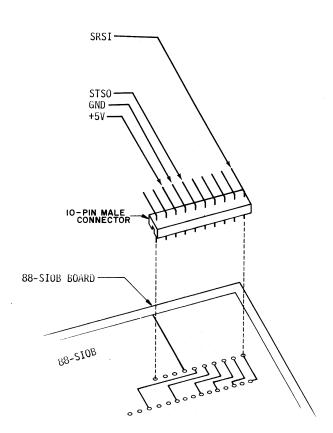


Make all hardwire connections as described in the instructions.

Wafer Connector Installation

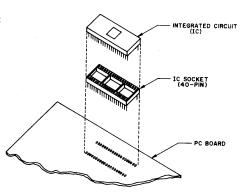
There is one 10-pin male connector to be installed on the $8800~{\rm Serial}$ I/O B Board.

- () Referring to the drawing below, insert the 10-pin wafer connector into the correct holes on the board from the silk-screened side. Be sure to insert the side with the shorter, straight pins.
- () Holding the connector in place, turn the board over and solder the 10 pins to the foil pattern on the back side of the board.



Board Installation

- () IC M may now be installed into its socket on the 8800 Serial I/O B board. Do this very carefully and remember this is a MOS integrated circuit and very sensitive to static electricity.
- () Refer to page 64 in the assembly manual "EXPANDER BOARD 8800 M/BD ASSEMBLY" and install the edge connector provided with the board according to the procedure described there.
- () Press the 8800 Serial I/O B Board into the edge connector just installed. The board should be oriented the same way as the other boards already installed; i.e. the silkscreened side should be facing the right side of the unit viewed from the front panel.



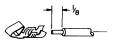
GO TO MODEM BOARD ASSEMBLY

I/O Connector Wiring

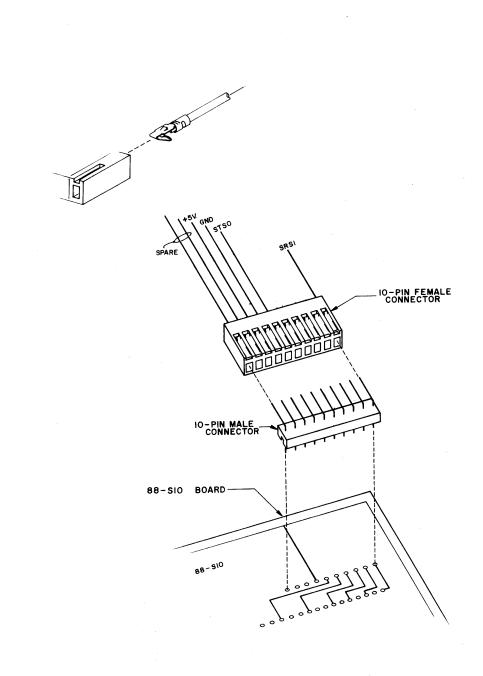
There is a 10-pin female connector provided with your kit, along with a multiconductor cable. These must be wired together according to the following procedure.

- () Using a small sharp knife, strip 1 1/4 inches of cable sheath from one end and 2 inches of cable sheath from the other end of the cable. Do this by cutting a circle around the sheath, being very careful not to cut into the insulation of the wires inside, and pulling the end off of the wires.
- () On the end with 1 1/4 inches of wires exposed, strip 1/8 inch of insulation from the ends of each of the wires and tin the exposed portion by applying a thin coat of solder.
- () Referring to the drawing below, install one of the connector pins onto the end of each of the necessary wires. Do this by crimping the wire into place; then soldering the end to the pin itself. The number of wires used will depend on whether pwr. & gnd. are required externally.

() Referring to the drawing on the following page, insert the pins one at a time into the female connector. As you insert each pin, note the color of the wire and label the same wire on the opposite end with the designation indicated on the drawing. It is very important that you maintain the wire orientation indicated in the drawing.







I/O Device Interconnections

The following signals are available on the 8800 Serial I/O B Board I/O Connector.

STSO----Serial Data Output

SRSI----Serial Data Input

GROUND

 ± 5 VOLTS--(do not use unless external power is required, and do not use greater than 100ma.)

There are also several spare pins which are not used.

The signa's on this board have the following characteristics:

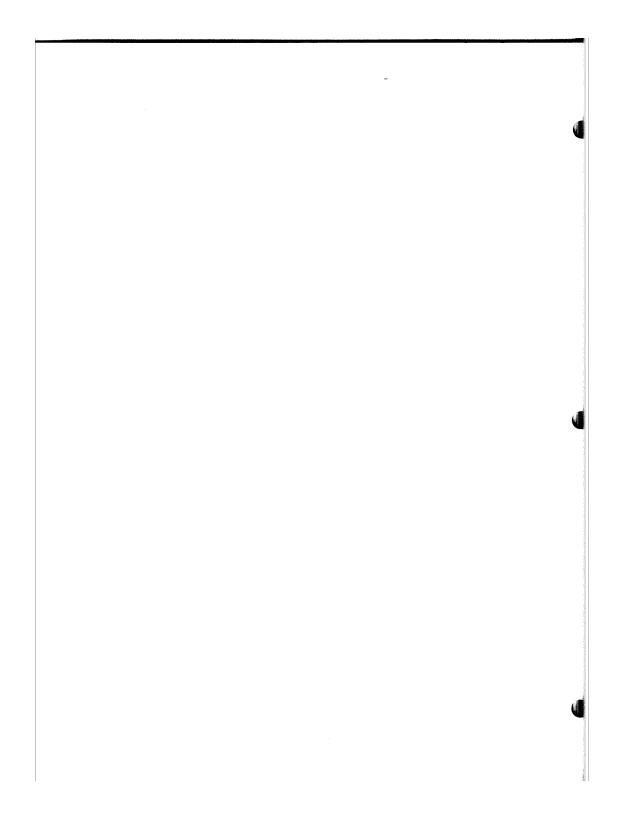
logic high level = +2v min., +5.5v max.--output current 40ma

logic low level = -1.5v min., +.8v max.--input current 500ua

There are several openings provided in the 8800 Back Panel for interfacing connections to exit the computer.

The connections to the device itself are to be \max according to the device specifications.

There are spaces provided on the side of the back panel opposite the transformers for the mounting of 25-pin connectors. Both male and female connectors are included with your kit. These connectors are to be wired according to the device specifications also.



I/O ADDRESS SELECTION CHART

ADDRESS	CONNECTIONS											
OCTAL		17	16	15	<u> 14</u>	I3	I2	<u> </u>				
000		Ā7	Ā6	A5	A4	A3	A2	AT				
002		A7	Ā6	A5	A4	A3	A2	A1				
004		Ā7	Ā6	A5	A4	Ā3	A2	Ā1				
006		A7	Ā6	A5	A4	A3	A2	A1				
010		A7	A6	Ā5	Ā4	АЗ	A2	Ā1				
012		A7	A6	A5	A4	А3	A2	A1				
014		A7	Ā6	A5	A4	А3	A2	A1				
016		A7	Ā6	Ā5	A4	А3	A2	A1				
020		A7	Ā6	Ā5	A4	Ā3	Ā2	A1				
022		Ā7	Ā6	A5	A4	A3	A2	A1				
024		A7	A6	A5	A4	A3	A2	A1				
026		A7	Ā6	A5	A4	A3	A2	A1				
030		A7	Ā 6	A5	A4	АЗ	Ā2	Ā1				
032		A7	Ā6	Ā5	A4	АЗ	A2	A1				
034		A7	Ā6	A5	A4	АЗ	A2	A1				
036		A7	Ā6	Ā5	A4	АЗ	A2	Al				
040		A7	Ā6	A5	A4	A3	A2	A1				
042		A7	Ā 6	A 5	Ā4	A3	A2	A1				
044		A7	Ā6	A5	ĀĀ	A3	A2	A1				
046		A7	Ā6	A5	A4	A3	A2	A1				
050		A7	Ā6	A5	Ā 4	А3	A2	ĀĪ				
052		A7	Ā6	A5	A4	А3	A2	A1				
054		Ā7	Ā6	A 5	A4	АЗ	A2	ĀĪ				
056		A7	Ā6	A5	A4	А3	A2	ΑΊ				
060		A7	Ā6	A5	A4	A3	A2	A1				

ADDRESS OCTAL	<u> 17</u>	12	11				
062	Ā7	Ā6	A5	A4	A3	A2	A1
064	A7	Ā6	A5	A4	A 3	A 2	AT
066	A7	Ā6	A5	A4	A3	A2	Al
070	A7	Ā6	A5	A4	А3	Ā2	A1
072	A7	Ā6	A5	A4	А3	A2	A1
074	A7	Ā6	A5	A4	А3	A2	A1
076	A7	Ā6	A5	A4	А3	A2	Al
100	Ā7	A6	A5	A4	A3	A2	ĀĪ
102	Ā 7	A 6	A5	A4	A3	A2	Al
104	Ā7	A6	Ā5	A4	A3	A2	Āī
106	A7	A6	Ā5	A4	Ā3	A2	A1
110	A7	A6	Ā5	A4	А3	A2	. A1
112	Ā7	A6	Ā5	A4	А3	<u>A2</u>	A1
114	A7	A6	Ā5	A4	А3	A2	A1
116	Ā7	A6	Ā5	A4	А3	A2	Αī
120	A7	A6	A5	A4	A3	A2	AT
122	Ā7	A6	Ā5	A4	A3	A2	A1
124	A7	A6	Ā5	A4	A3	A2	A1
126	A7	A6	A5	A4	A3	A2	A1
130	Ā7	A6	A5	A4	А3	A2	ĀĪ
132	A7	A6	Ā5	A4	А3	A2	A1
134	A7	A6	Ā5	A4	А3	A2	ĀĪ
136	A7	A6	Ā5	A4	А3	A2	A1
140	A7	A6	A5	A4	A3	<u>A2</u>	ĀĪ
142	A7	A6	A5	A4	A3	A2.	A1

ADDRESS OCTAL	17	I6	ONNECTI	13	12	. 11	
144	Ā7	A6	A 5	Ā4	Ā3	A2	ĀĪ
146	A7	A6	A 5	Ā4	A3	A2	A]
150	Ā 7	A6	A5	A4	АЗ	A2	A1
152	A7	A6	A5	A 4	А3	A2	A1
154	Ā7	A6	A5	A 4	А3	A2	ĀĪ
156	A7	A6	A5	A4	АЗ	A2	A1
160	Ā 7	A6	A5	A4	A3	A2	Ā1
162	Ā7	A6	A5	A4	A3	A2	A1
164	Ā7	A6	A5	A4	A3	A2	AT
166	Ā7	A6	A5	A4	A3	A2	Α1
170	Ā7	A6	A 5	A4	А3	A2	ĀĪ
172	Ā7	A6	A5	A4	А3	A2	ΑΊ
174	Ā7	A6	A5	A4	A3	A2	A1
176	A7	A6	A5	A4	А3	A2	A1
200	A7	Ā6	Ā5	A4	A3	Ā2	A1
202	A7	Ā6	Ā5	A4	Ā3	Ā2	Al
204	A7	Ā6	A5	Ā4	A3	A2	ĀT
206	A7	A 6	Ā5	Ā4	A3	A2	A1
210	A7	Ā6	Ā5	A4	А3	A2	ĀT
212	A7	Ā6	Ā5	Ā4	А3	A2	A1
214	A7	Ā6	Ā5	A 4	А3	A2	ĀT
216	A7	Ā6	A5	A4	А3	A2	A1
220	A7	A6	A5	A4	A3	A2	Āī
222	A7	Ā6	A5	A4	A3	Ā2	ΑΊ
224	A7	Ā6	A5	A4	Ā3	A2	A1

ADDRESS OCTAL		16	CONNECT I5	IONS I4	13	12	
226	A7	Ā6	Ā5	A4	A3	A2	Α1
230	A7	Ā6	Ā5	A4	А3	Ā2	AT
232	A7	A6	Ā5	A4	А3	A2	Al
234	Α7	Ā6	Ā5	A4	А3	A2	ĀĪ
236	A7	A6	Ā5	A4	А3	A2	A1
240	A7	Ā6	A5	A 4	A3	Ā2	A1
242	A7	Ā6	A5	A4	A3	A2	Al
244	A7	Ā6	A5	A4	A3	A2	AT
246	A7	Ā6	A5	A4	Ā3	A2	A1
250	A7	A6	A5	A4	А3	A2	AT
252	A7	Ā6	A5	A 4	А3	A2	Αl
254	A7	Ā6	A 5	A4	А3	A2	A1
256	A7	Ā6	A5	A4	А3	A2	A1
260	A7	Ā6	A5	A4	A3	A2	A1
262	A7	Ā6	A5	A4	Ā3	A2	A1
264	A7	Ā6	A5	A4	Ā3	A2	AT
266	A7	Ā6	A5	A4	Ā3	A2	A1
270	A7	A6	A5	. A4	А3	A2	ĀT
272	A7	Ā6	A5	A4	А3	A2	A1
274	A7	Ā6	A5	A4	АЗ	A2	A1
276	A7	Ā6	A5	A4	А3	A2	A1
300	A7	A6	A5	ĀĀ	A3	A2	A1
302	A7	A6	A5	Ā 4	A3	A2	Al
304	A7	A6	Ā5	A4	Ā3	A2	AT
306	A7	A6	Ā5	Ā4	A3	A2	A1

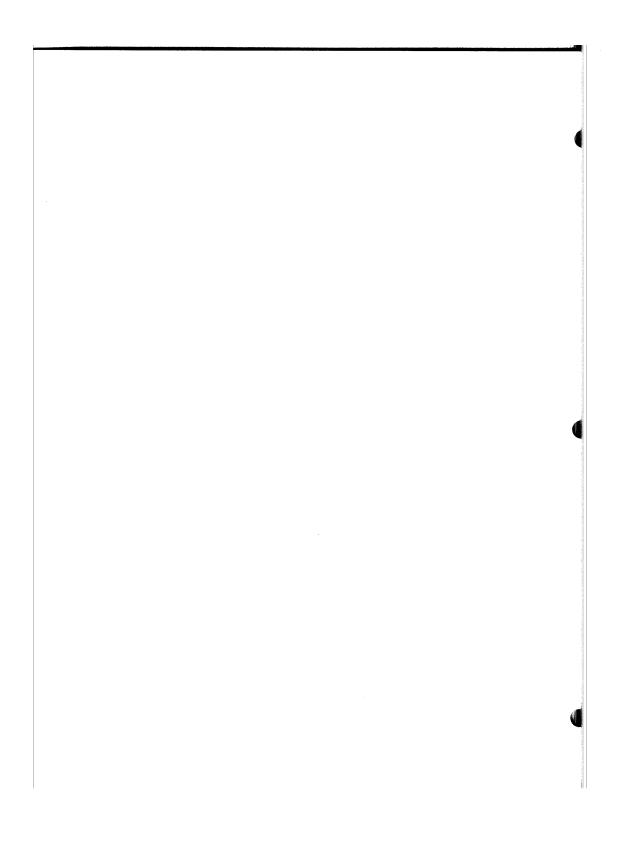
ADDRESS	CONNECTIONS							
OCTAL	<u>I7</u>	16	15	14	I3	12	I	
310	A7	A6	A5	Ā4	A3	A2	Ā	
312	A7	A6	Ā5	A 4	А3	A2	A.	
314	A7	A6	A5	A4	A3	A2	Ā	
316	A7	A6	Ā5	A4	А3	A2	А	
320	A7	A6	Ā5	A4	A3	A2	Āī	
322	A7	A6	A5	A4	Ā3	A2	A1	
324	A7	A6	A5	A4	A3	A2	Ā1	
326	A7	A6	A 5	A4	Ā3	A2	A1	
330	A7	A6	A5	A4	А3	A2	AT	
332	A7	A6	A5	A 4	А3	A2	A1	
334	A7	A6	A5	A4	А3	A2	ĀĪ	
336	A7	A6	A5	A4	А3	A2	A1	
340	A7	A6	A5	A4	A3	Ā2	A1	
342	A7	A 6	A5	Ā4	A3	A2	A1	
344	A7	A6	A 5	A4	Ā3	A2	Ā1	
346	A7	A6	A5	A 4	A3	A2	A1	
350	A7	A6	A5	A4	АЗ	A2	ĀT	
352	A7	A 6	A5	A 4	А3	A2	Αì	
354	A7	A6	A 5	Ā4	А3	A2	ĀT	
356	A7	A6	A 5	A4	А3	A2	A1	
360	A7	A6	A5	A4	A3	A2	ĀT	
362	A7	A6	A5	A4	Ā3	Ā2	A1	
364	A7	A6	A5	A4	A3	A2	AT	
366	A7	A6	A5	A4	A3	A2	Α1	
370	A7	A6	A5	A4	А3	A2	ĀĪ	

ADDRESS			Ċ						
OCTAL	17	16	15	14	13	I2		_	
372		A7	A6	A5	A4	А3	A2	A1	
374		A7	A6	A5	A4	А3	A 2	AT	
376		A7	A6	A5	A4	А3	A2	A1	

I/O BAUD RATE SELECTION CHART

In the chart below, PRESET COUNT pads 0 through 11 correspond to pads 0 through 11 on the right side of the 1/0 board. The BAUD rate listed on the left can be obtained by wiring pads 0 through 11 according to the information in the chart; with "+V" for a 1 and "GND" for a 0.

BAUD RATE	PRESET COUNT												
	11	10	9	8	7	6	5	4	3	2	1	0	
110	1	0	1	1	1	0	0	1	0	1	0	0	
150	1	1	0	0	1	1	0	0	0	0	1	1	
ACR → 300	1	1	1	0	0	1	1	0	0	0	1	1	
600	1 .	1	1	1	0	0	1	1	0	1	0	0	
1200	1 .	1	1	1	1	0	0	1	1	1	0	0	
2400	1	1	1	1	1	1	0	1	0	0	0	0	
4800	1	1	1	1	1	1	1	0 ,	1	0	1	0	
9600	1	1	1	1	1	1	1	1	1	0	0	0	
19200	1	1	1	1	1	1	1	1	1	1	1	0	



MODEM BOARD

PROCEDURE

Integrated Circuit Installation

There are 8 integrated circuits (IC's) to be installed on the 88-ACR Modem Board.

Install each of the IC's according to the following procedure:

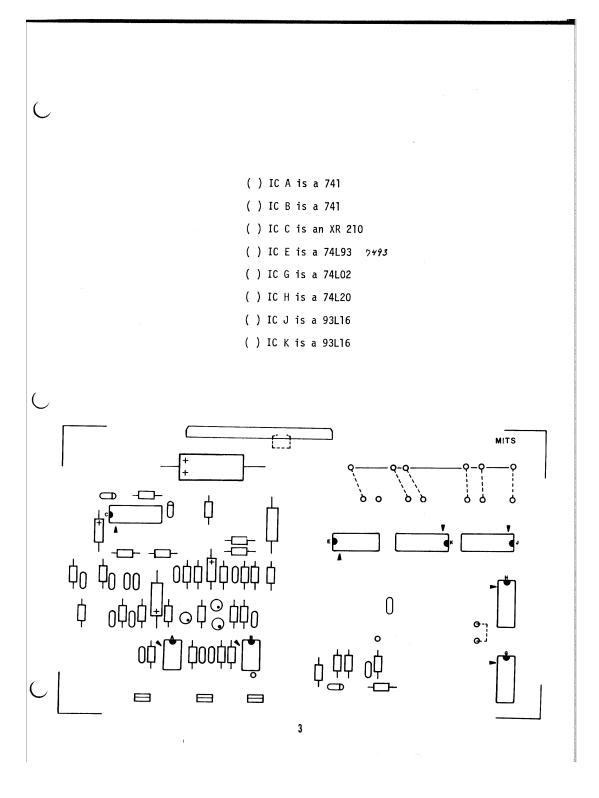
- () Referring to the component layout, remove the IC with the correct part number from its holder. If there are any bent pins, straighten these using needle-nose pliers. Ensure that you choose the IC with the correct part number.
- () Orient the IC so that its notched end corresponds with the notch printed on the board, and pin 1 of the IC corresponds with the arrowhead printed on the board.

NOTE: If the IC does not have a notch on one end, refer to the IC Orientation Chart included in your manual for the identification of pin 1.

() When you have the correct orientation, start the pins on one side of the IC into their respective holes on the silk-screened side of the PC board. DO NOT PUSH THE PINS IN ALL THE WAY. If you have difficulty getting the pins into the holes, use the tip of a small screwdriver to guide them.

- () Start the pins on the other side of the IC into their respective holes in the same manner. When all of the pins have been started, set the IC into place by gently rocking it back and forth until it rests as close as possible to the board. Make sure that the IC is perfectly straight and as close to the board as possible; then tape it in place with a piece of masking tape.
- () Turn the board over and solder each pin of the IC to the foil pattern on the back side of the board. Be sure to solder each pin, and be careful not to leave any solder bridges.
- () Turn the board over again and remove the piece of masking tape.

Use the same procedure to install each of the IC's. Be sure that you have the correct part number and the correct orientation as you install each one.



Resistor Installation

There are 30 resistors to be installed on the 88-ACR Modem Board.

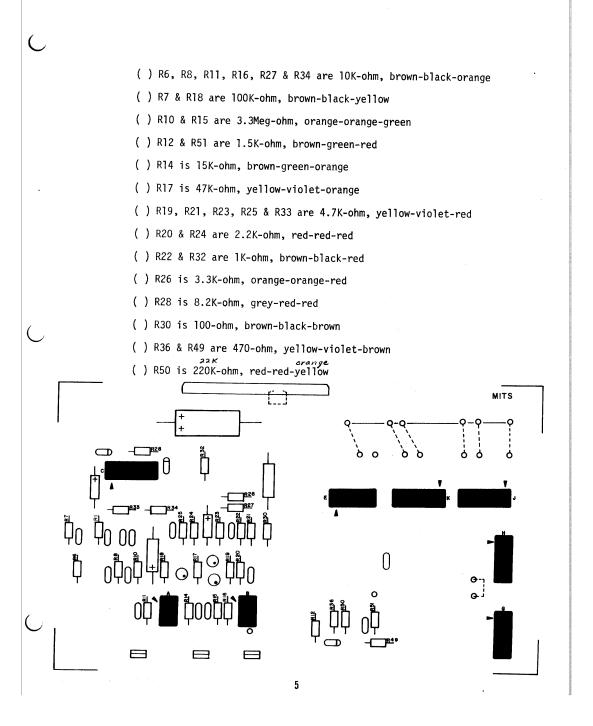
NOTE: Resistors are color-coded according to their value. The resistors in your kit will have four or possibly five bands of color. The fourth band in both casis will be gold or silver, indicating the tolerance. In the following instructions we will be concerned only with the three bands of color to one side of the gold or silver band. Be sure to match these three bands of color with those called for in the instructions as you install each resistor.

Using needle-nose pliers, bend the leads of the resistors at right angles to match their respective holes on the PC board. (see component layout)

 $\frac{\text{NOTE}}{\text{Board}}$: All resistors on the 88-ACR Modem Board may be either 1/4 or 1/2 Watt.

- () Insert resistor R1 (4.7K-ohm, yellow-violet-red) into the correct holes from the silk-screened side of the PC board. (see component layout)
- () Holding the resistor in place with one hand, turn the board over and bend the two leads slightly outward.
- () Solder the leads to the foil pattern on the back side of the board; then clip off any excess lead lengths.

Referring to the component layout, install the remaining resistors in the same manner. Be sure you have the correct color-coding for each one as you install them.



Trim Pot Installation

There are 3 trim pots (variable resistors) to be installed on the $88\mbox{-}ACR$ Modem Board.

BACK SIDE OF BOARD

There are two different value pots used on the board; R9 & R13 are 25K-ohms and R29 is 500-ohms. The identification markings on the three pots will be as follows:

R9 & R13 will be marked either "25K" or MTC253L1, R29 will be marked either "500" or MTC52L1.

- () Insert trim pot R9, 25K-ohms (MTC 253L1), into the correct holes from the silk-screened side of the PC board. The pot should mount vertically in the board into the three holes provided with the correct triangular spacing.
- () Turn the board over and solder the three leads to the foil pattern on the back side of the board.

Install trim pots R13 & R29 in the same manner. Be sure you have the correct value pot in the correct location, and check to see that there are no solder bridges.

() R9 is 25K-ohms, MTC 253L1() R13 is 25K-ohms, MTC 253L1 () R29 is 500-ohms, MTC 52L1 **⊟**89 7

Capacitor Installation

There are 19 capacitors to be installed on the 88-ACR Modem board. Four of these are electrolytic, one is mylar, and the others are ceramic disk capacitors.

Refer to the component layout and install the mylar and ceramic disk capacitors according to the following procedure.

- Choose the capacitor with the correct value as called for in the instructions. Straighten the two leads as necessary and bend them to fit their respective holes on the PC board.
- () Insert the capacitor into the correct holes from the silk-screened side of the board. Push the capacitor down until the insulation on the leads almost touches the foil pattern.
- Holding the capacitor in place, turn the board over and bend the two leads slightly outward.
- () Solder the two leads to the foil pattern on the back side of the board; then clip off any excess lead lengths.

Install all of the ceramic disks and the mylar in this manner. Be sure that you have the correct value capacitor as you install each one.

The three electrolytic capacitors for the Modem board have polarity requirements which must be noted before installation. Those contained in your kit may have one or possibly two of three types of polarity markings. To determine the correct orientation, look for the following: (see drawing above right)



ELECTROLYTIC CAPACITOR



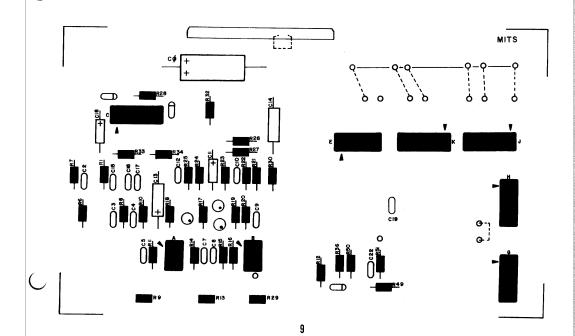
One type will have plus (+) signs on the positive end; another will have a band or a groove around the positive side in addition to the plus signs. The third type will have an arrow on it; in the tip of the arrow there is a negative (-) sign and the capacitor must be oriented so the arrow points to the negative polarity side

Referring to the component layout, install the electrolytic capacitors onto the board according to the following procedure.

- () Bend the two leads of the capacitor with the correct value at right angles to match their respective holes on the board. Insert the capacitor into the holes from the silk-screened side of the board. Be sure to align the positive polarity side with the "+" signs printed on the board.
- () Holding the capacitor in place, turn the board over and bend the two leads slightly outward. Solder the leads to the foil pattern and clip off any excess lead lengths.

Install all 4 electrolytic capacitors in this manner.

() C2 is .01uf
() C3 is .001uf
() C4, C5, C7 & C8 are 470pf
() C9, C10, C12, C19 & C22 are .1uf
() C14 is .15uf mylar
() C15, C16 & C17 are .033uf
() C0 is 500uf (Back side of Goard)
() C11 is luf
() C13 is 35uf
() C18 is 4.7uf



Diode Installation

There are two 1N914 diodes and one 12v zener diode to be installed on the 88-ACR Modem Board.

NOTE: Diodes are marked with a band on one end indicating the cathode end. The diode <u>must be oriented</u> so that the end with the band is towards the band printed on the board when being installed.

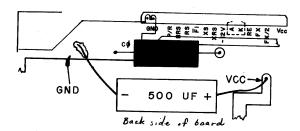
- () Referring to the component layout, bend the leads of zener diode Z1 at right angles to match the correct holes on the board.
- () Insert the diode into the correct holes from the silk-screened side of the board. Turn the board over and bend the two leads slightly outward.
- () Solder the two leads to the foil pattern on the back side of the board; then clip off any excess lead lengths.

Install 1N914 diodes D3 & D4 in the same manner. Be sure you have the correct orientation as you install each one.

88-ACR ERRATA SHEET

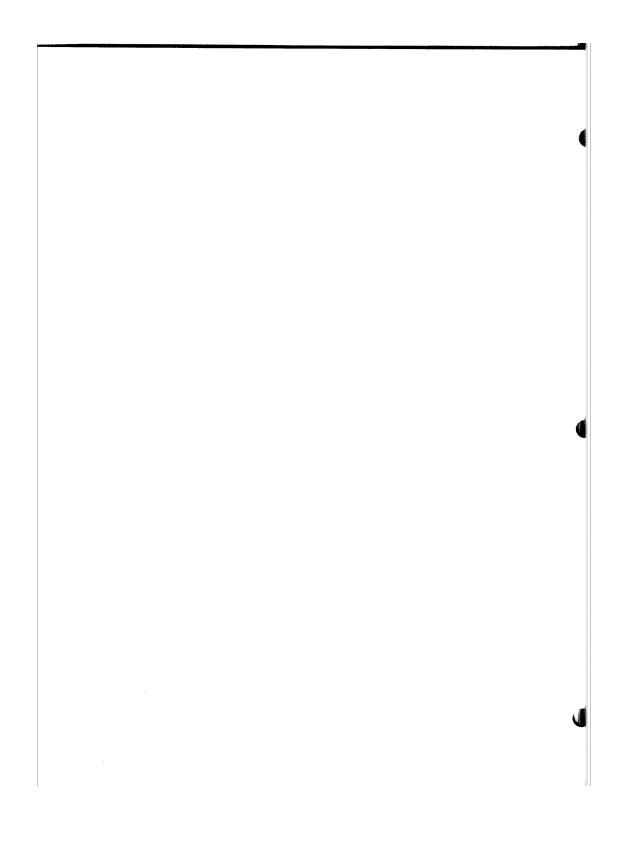
THE FOLLOWING ADDITIONS ARE TO BE MADE TO THE 88-ACR MODEM BOARD ASSEMBLY PROCEDURE ON THE PAGES INDICATED:

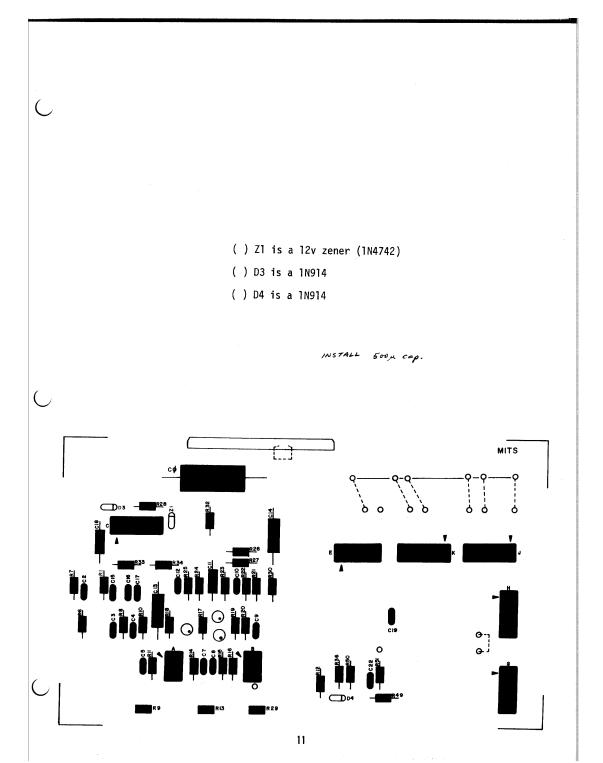
AFTER COMPLETING THE INSTRUCTIONS ON PAGES 10 & 11, INSTALL A 500uf ELECTROLYTIC CAPACITOR IN THE POSITION SHOWN IN THE DRAWING BELOW. BE CAREFUL NOT TO SHORT THE CAPACITOR LEADS TO ANY OTHER LANDS OR COMPONENTS. SOLDER THE NEGATIVE LEAD DIRECTLY TO THE PC LAND INDICATED IN THE DRAWING, AND INSERT THE POSITIVE LEAD INTO THE FEEDTHROUGH HOLE INDICATED.



PAGES 18 & 19: BEFORE INSERTING THE SCREW CLOSEST TO THE HEAT SINK ON THE S I/O B BOARD, PLACE A .15 INCH PLASTIC SPACER OVER IT. THIS IS TO INSULATE THE SCREW FROM THE PC LANDS ON THE S I/O B BOARD ITSELF.

Do to all 3 screws





Transistor Installation

There are three transistors to be installed on the 88-ACR Modem Board, 1 NPN (CS4410) and 2 PNP (EN2907).

NOTE: When installing these transistors, ensure that you check the part numbers on them before soldering them into place. Some transistors are identical in physical appearance but differ in electrical characteristics. If the part numbers on your transistors do not match the numbers called for in the instructions, it may be that you have substitutions. In this case, refer to the Transistor Identification Chart included with your manual.

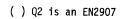
() These transistors are rounded and have a flat edge near one of the leads. The lead nearest this flat edge is called the emitter. The hole for the emitter is the one marked with a dot and the letter "E" on the board. If the emitter lead is placed into this hole, the other two leads should fit into their holes with little or no bending and should not cross over each other. (see drawing below)

- () Orient transistor Q2 (EN2907) so that the lead nearest the flat edge aligns with the correct hole on the board. Insert the transistor into the holes from the silk-screened side of the board.
- Holding the transistor in place, turn the board over and bend the three leads slightly outward.
- () Solder the leads to the foil pattern on the back side of the board; then clip off any excess lead lengths.

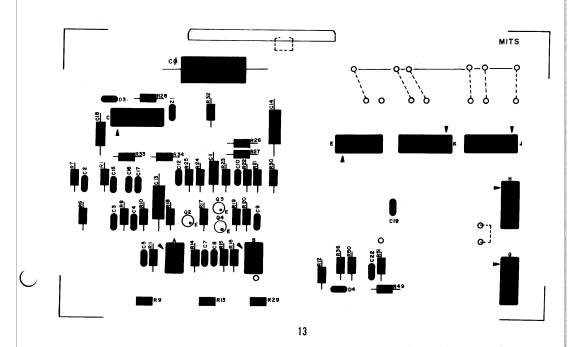
Referring to the component layout, install transistors Q3 & Q4 in the same manner. Be sure that you have the correct part number and the correct orientation for each one as you install them.







- () Q3 is an EN2907
- () Q4 is a CS4410



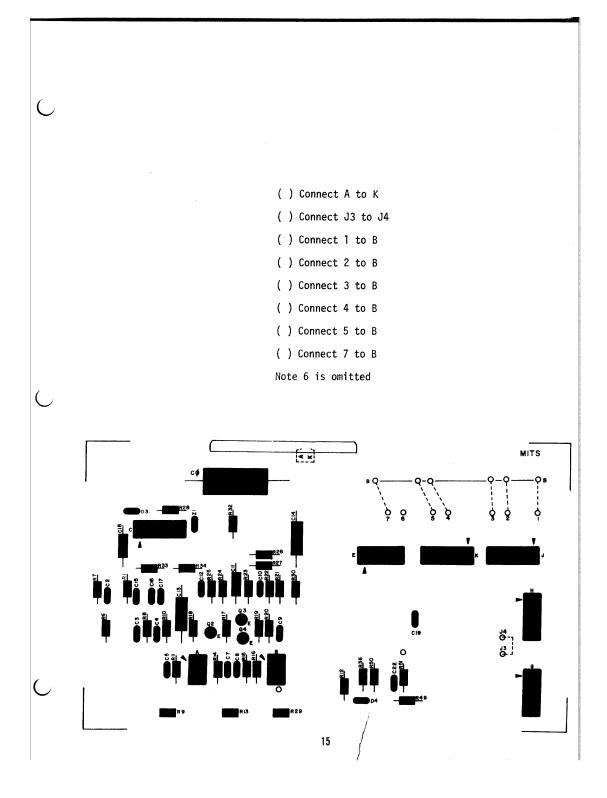
Hardwire Jumper Installation

There are 8 hardwire connections to be made directly on the $88\mbox{-}ACR$ Modem Board.

These connections are to be made using the 1 1/2 inch wires provided with your kit as follows:

- Insert the jumper wires one at a time into the correct holes from the silk-screened side of the PC board.
- () Turn the board over and solder each of the leads to the foil pattern on the back side of the board. Clip off the excess wire lengths.

The positions on the board for the jumpers are indicated by two pads with a particular designation and connected by a broken line. (see component layout)



88-ACR Modem/SIO B Board Interface

There are 10 hardwire jumper connections to be made between the 88-ACR Modem Board and the Serial I/O B (TTL) Board.

Use the 8 inch wires provided with your kit to make all of these connections.

() Orient the two boards in front of you with the silk-screened sides facing down. The edge connector contacts on the S I/O board should be touching the side of the Modem Board closest to capacitor CO.

The boards may be moved from this position in order to locate the connection points; but, this is the position to maintain the proper spacing for the wires when making the connections. All of the connections should be made from the nonsilk-screened sides of the boards.

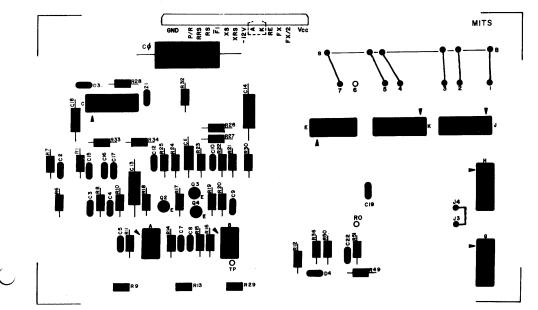
Some of these connections will be made to the pins on the S I/O board wafer connector. These pins protrude slightly from the back side of the board and are fairly close together. Exercise great care when making these connections in order to prevent shorts between pins or between pins and PC lands.

Connect the following points on the two boards according to the instructions above:

- () "RO" on the Modem to the leftmost wafer connector pin (Spare) as viewed from the silk-screened side of the S I/O board.
- () "P/R" on the Modem to the second pin on the wafer connector (Spare) of the S I/O board.

- () Connect separate wires to the two pads "GND" on the Modem and join the other ends together to the "GND" pad on the wafer connector of the S I/O board.
- () In the same manner connect with 2 wires the pads "Vcc" on the Modem to the "+5V" pin of the connector on the S I/O board.
- () "RS" on the Modem to "SRSI" on the wafer connector of the S I/O board.
- () "XS" on the Modem to "STSO" on the wafer connector of the S I/O board.
- () "FT" on the Modem to "SO" on the S I/O board (pad located between IC's Q & R)
- () "-12V" on the Modem to -12v on the S I/O board. This pad may or may not be marked on the S I/O B board. It is located between C9 and IC K, and connects with the PC land which joins one end of R1 to the anode (non-banded) side of Z1.

Be sure to clip off any excess wire from the connections, and check over all of them on both boards to be sure there are no shorts or solder bridges. Make all interconnections as per the instructions.



88-ACR Modem/SIO B Board Mating

The 88-ACR Modem Board and the Serial I/O B Board must be mated together before installation to the ALTAIR.

The drawing on the opposite page shows the correct orientation for the two boards to be mated.

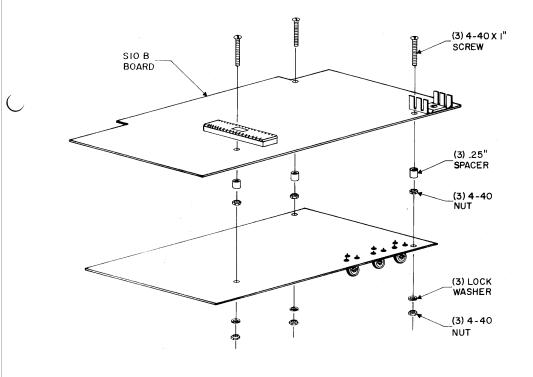
 Using the hardware supplied with your kit, mount the two boards together as shown in the drawing.

It is very important that you use the exact orientation shown in the drawing for both the boards and the connecting hardware.

.7" spacers
1/2" screws
Bock sides of boards face in

MATE THE TWO BOARDS AS SHOWN BELOW.

USE SPACERS TO INSULATE
FROM LANDS



I/O Interface Cable Assembly

There are two 20 inch lengths of shielded cable provided with your kit.

- () Using a small sharp knife, strip linch of the outer insulation from both ends of each of the two cables. Do this by cutting a small circle, linch from the end, around the cable and pulling the insulation off. Save the pieces you pull off for later use.
- () Separate the shielding from the inner wire, and twist its strands together as tightly as possible on each end.
- () Again, using a small sharp knife, strip 1/8 inch of insulation from the ends of the inner wires of both cables.
- () Cut 2 pieces of the insulation saved earlier and place them over the shielding wire on one end of the two cables so that only 1/4 inch of bare wire protrudes. Place this end of the two cables together and twist the 2 1/4" sections of shielding into one wire.
- () Referring to page 15 of the S I/O B board assembly procedure, attach a connector pin to each of the three wires on the side of the cables where the shields are joined.
- () Referring to page 16 of the S I/O B board assembly procedure, insert the three connector pins into the female connector in the following locations:

The pin connected to the two shields goes to "GND",
The two pins connected to the two inner wires each go to one of the two "Spare" positions.

This connects the inner wire of one cable to "RO" on the Modem board, and the inner wire of the other to "P/R" on the Modem board.

() Using a piece of masking tape, label the cable whose inner wire goes to the outside connector pin ("RO") with the words "Record Out". Label the other cable ("P/R") with the words "Play In".

There are two miniature phone jacks also included in your kit.

These jacks each have three solder terminals connected to them. You will observe one of the solder terminals to be connected directly to the center metal portion of the jack which runs through to the mounting threads.

- () Again, cut two pieces of the insulation saved earlier, and place them over the shielding on the two cables so that only 1/8 inch of bare shielding protrudes.
- Solder the shielding on the two cables to the two jacks on the solder terminal described above.

There are two mechanical contacts on the jacks. One of these is squared, and the other is curved and on the inside position. By observing the jacks from the side, it may be seen that the center of the three solder terminals is connected to the curved contact.

() Solder the inner wires of the two cables to the solder terminals described above on the two jacks.

Check the connections on both jacks to be sure there are no shorts and that the connections touch no other portion of the jacks but the solder terminals.

88-ACR & I/O Cable Installation

The two phone jacks can now be mounted onto the ALTAIR back panel.

There are two 1/4 inch holes near the bottom of the ALTAIR back panel, on the side opposite the transformers.

- () Using a piece of rough sandpaper or a small screwdriver blade, scrape the painted area around the two 1/4 inch holes on the <u>inside</u> of the case to expose the bare metal.
- () Remove the mounting hardware from the two phone jacks and place them into the 1/4 inch holes from the inside of the case.
- () Put the mounting hardware back onto the jacks and tighten them into place.

There are two foil labels included with your kit.

- () Remove the backing from the label "TAPE RECORD OUT" and place it over the jack, on the outside of the back panel, connected to the cable labeled "Record Out".
- () Remove the backing from the other label and place it over the other jack in the same manner.
- () Remove the tape labels from the two cables.
- () Attach the female connector on the opposite end of the two cables to the wafer connector on the SIO B board using the orientation described on the preceeding page.

The 88-ACR may now be installed into the ALTAIR main case.

The unit should be installed using the edge connector contacts of the SIO B board, with the same general orientation as the other boards in your system. The components on the SIO B board should be facing towards the right side of the ALTAIR as viewed from the front. As this unit consists of two boards, it should be installed in the last slot available on the "mother board" in the system.

88-ACR Alignment Procedure

There are two methods listed for the alignment of the 88-ACR. If an oscilloscope is available, the first method should be used.

Alignment with an Oscilloscope

Read over the section in this manual on Using the 88-ACR; then record the "Output Test Program", listed on page **27**, for approximately 15 minutes (one side of a C-30 cassette).

Once this is accomplished, rewind the tape and begin playing it back into the computer. For this purpose, no input program is necessary.

Place the oscilloscope to view the signal at the point labeled "TP" on the Modem board. The scope should be set at approximately 2v/div. vertically and 5ms/div. horizontally.

The point "TP" is the output of the two stage Op Amp filter. Reduce the volume on the recorder as necessary to give an unclipped output at this point.

Using an insulated alignment tool or insulated screwdriver, adjust the two trim pots located closest to the front panel (R9 & R13). Set them to give the maximum smooth output at "TP". It may be necessary to reduce the volume on the recorder during adjustment to prevent clipping of the signal.

If necessary rewind the tape and begin the program over. Set the tone and the volume controls of the recorder at maximum.

Set the oscilloscope to view the signal at "SRSI" on the connector on the SIO B board. Adjust the scope as necessary to view the following.

Trim pot R29 (closest to back panel) should now be adjusted for a +5 volt peak-to-peak square wave.

The signal should be symmetrical, high period = low period; and at a 300 BAUD setting it will be approximately 3.3ms per period (bit).

Alignment without an Oscilloscope

Read over the section in this manual on Using the 88-ACR; then record the "Output Test Program", listed on page 27, for approximately 15 minutes (one side of a C-30 cassette).

The two trim pots closest to the front panel (R9 & R13) should be placed in the center position of their full adjustment travel. These are the trim pots for the Op Amp filter and are not critical. They should be left in this position.

The "Input Test Program", listed on page 28, should now be loaded into the computer.

Once this is accomplished, begin playing the tape into the computer as described in the section on Using the 88-ACR.

With the system functioning normally, if trim pot R29 is not adjusted properly, address lights AO, Al & A2 only will be lighted.

Using an insulated alignment tool or insulated screwdriver, slowly adjust R29 back and forth until all of the address lights AO through A7 light, indicating the Test Word is being received properly.

There will be approximately 1/8 turn of travel where this occurs. Find the end points where the signal is lost and set the pot exactly in the center of this area of travel.

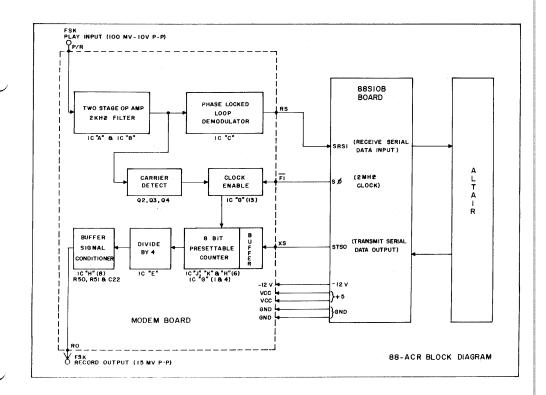
Theory of Operation

88-ACR OPERATION

The $88\mbox{-}ACR$ consists of an $88\mbox{-}SIO$ B, Serial TTL level I/O board, with a Modem board mated to it.

The Theory of Operation for the SIO B board is contained in its own documentation section within this manual.

Use the block diagram below for reference while reading the Theory of Operation for the Modem (Modulator-Demodulator) board which follows.



Modulator Operation

When an output program is running, serial data is being outputted on the "STSO" line from the 88-SIO B board. The changing logic levels are presented to the presettable counters, IC's J & K.

The counters (J & K) divide the 2MHz clock by 225 for a logic l input, and by 247 for a logic 0 input from the SIO B board. The output of IC K is further divided, by 4, using IC E. The resulting frequencies are 2225 Hz for a logic l input, and 2025 Hz for a logic 0 input from the SIO B board.

These signals are fed to the "Buffer Signal Conditioner". Here they are changed from TTL logic level square waves to 10mv peak-to-peak sawtooth waves suitable for the "Mic" inputs of tape recorders.

From the signal conditioner the signal is fed through the SIO B board connector and the shielded cable to the "Tape Record Out" jack on the back of the ALTAIR.

 ${\color{red} {\tt NOTE}}:$ "STSO" is normally a logic 1 with no data being trans transferred.

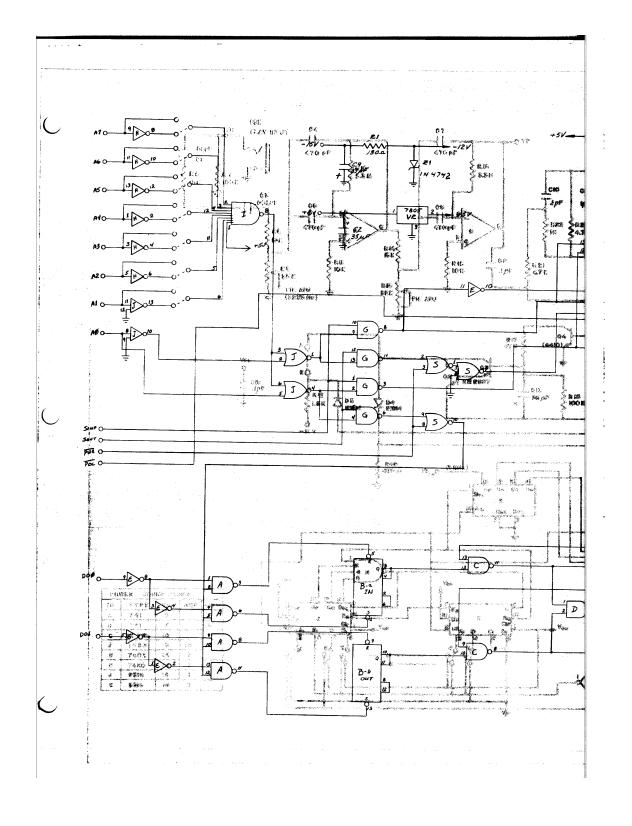
Demodulator Operation

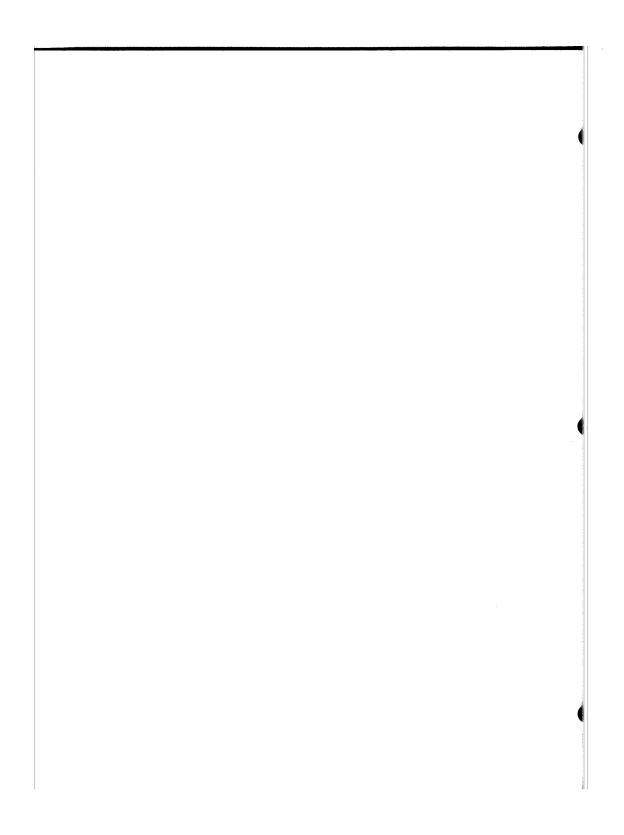
When playing a tape to load data, the output of the tape recorder is fed into the miniature phone jack labeled "Tape Play In" on the back of the ALTAIR. At this point the audio levels should be between 35mv RMS to 3.5v RMS for proper operation.

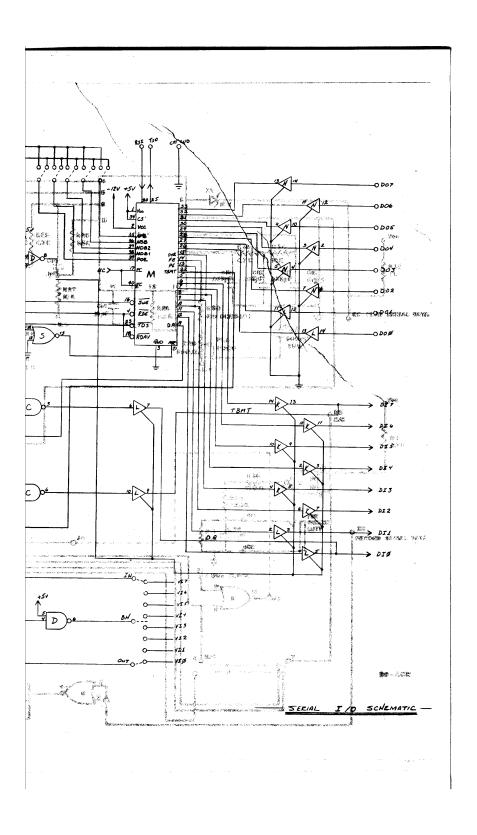
This signal is fed by shielded cable through the connector on the SIO B board to the "P/R" connection on the Modem board. The signal is then filtered by IC's A & B and fed into the demodulator, IC C. The output of IC B is also fed to a carrier detector circuit (Q2, Q3 & Q4) that enables IC C and disables the 2MHz clock going to the modulator circuit.

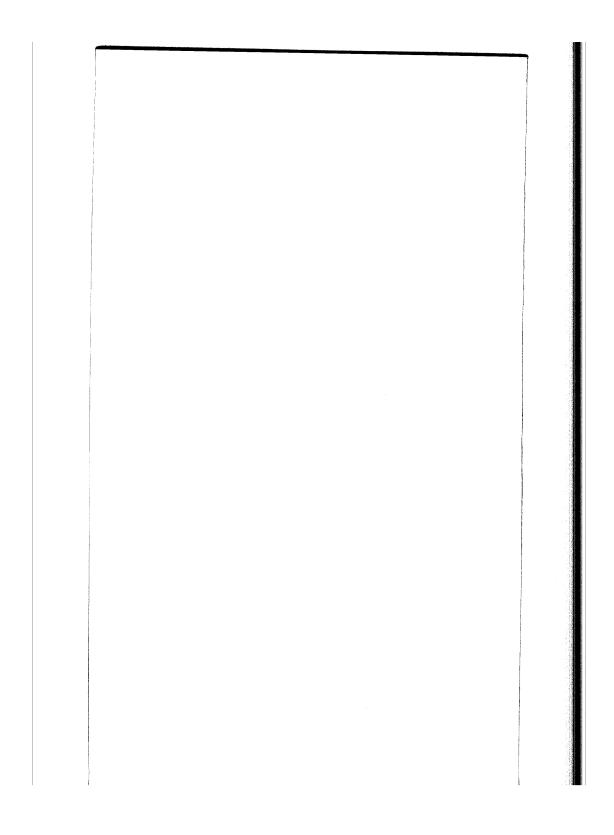
IC C is a Phase Locked Loop which compares the frequency of the incoming signal with the frequency of its internal oscillator, which is set halfway between 2025 and 2225 Hz. The output of IC C is a corresponding logic 1 for 2225 Hz, or a logic 0 for 2025 Hz on its input.

A zener diode interfaces the output of IC C to TTL logic levels, which are then fed from "RS" on the Modem board to "SRSI" on the SIO B board.









USING THE 88-ACR

The 88-ACR Audio-Cassette Record Interface is designed to be used with any medium quality or better cassette tape recorder. Music quality recorders generally give better performance than smaller portable recorders.

If a stereo recorder is used, you may record on one track at a time. This will double the storage capacity, but prevent playback on any momaural machine.

Keep the recorder away from power transformers, flourescent lamps and other sources of electrical noise when recording or playing back tapes. For maximum performance, use lownoise tape when making all recordings.

Be sure that only the "Play In" or the "Record Out" of the 88-ACR is connected at any one $t\bar{1}me$; never both.

Making a Recording From the 88-ACR

After a program has been loaded into the computer, connect "RECORD OUT" of the 88-ACR to the "Mic" of the recorder.

With the computer in a stopped condition, place the recorder into the record mode. Allow the recorder to run for at least 10 seconds, to allow for sufficient leader, before hitting the "RUN" switch on the computer. If you have a tape counter, start recording at "000" and hit the "RUN" switch at "015" to start recording data. Make note of the start and stop count of the data recorded.

If possible, it may be helpful to monitor the recording by listening with an earphone. This will give you a general indication if the 88-ACR and your program are functioning properly, and the data is actually reaching the recorder.

Most recorders use automatic level record circuits that need no adjustment of volume or tone settings during recording. If your recorder requires setting the record level, use 0 db or maximum undistorted level for recording.

Use this procedure for recording any data on cassette tape.

Loading Data From Tape with the 88-ACR

Before data may be loaded into the computer from a cassette tape, an input program of some type (e.g. Input Test Program) must first be loaded.

Once the input program is loaded, connect "PLAY IN" of the 88-ACR to the "Speaker", "Earphone" or "Line Out" output of your recorder. The volume and tone controls should be at their maximum settings.

Start playing the tape at the beginning of the leader ("000" if you have a tape counter); then hit the "RUN" switch on the computer \underline{before} the data starts.

When the data input is complete, as indicated by the tape counter or halting of the input program, the recorder may be stopped.

This procedure should be used any time data is to be loaded from a cassette tape.

OUTPUT TEST PROGRAM

The following is a listing of the output program used to write test data onto tape. This will be used for the alignment of the 88-ACR Demodulator. The program may be used with any memory size, 256 words or larger.

This program will record the test byte (125) until the program is manually stopped. The program is written using I/O address 0 for status and I/O address 1 for data. If your board address has been wired differently, change the program accordingly.

ADDRESS LOCATION (octal)	OCTAL CODE	MNEMONIC	DESCRIPTION
200	333	IN	Input
201	000	-	I/O Port Status Address
202	346	ANI	And immediate with A
203	002		Anded datamask for transmit buffer empty
204	332 312	JZ	Jump on zero
205	200		Lo-
206	000		Address jumped to if zero Hi—accumulator
207	076	MVI	Move immediate to A
210	125		TEST BYTE
211	323	OUT	Output
212	001		I/O Port Data Address
213	303	JMP	Jump unconditional
214	200		Lo-
215	000		Starting address of routine

INPUT TEST PROGRAM

The following is a listing of the program for playback of the Output Test Program. This program will also be used for the alignment of the 88-ACR Demodulator. It is written using the same I/O port addresses as the other program stated above, and should be changed accordingly if necessary.

ADDRESS LOCATION (octal)	OCTAL CODE	MNEMONIC	DESCRIPTION
000	333	IN	Input
001	000		I/O Port Status Address
002	346	ANI	And immediate with A
003	040		Anded datamask for recieve data available
004	332 312	JZ	Jump on zero
005	000		Lo-
006	000		Address jumped to if zero Hi— accumulator
007	333	IN	Input
010	001		I/O Port Data Address
011	356	XRI	Exclusive Or immediate with A
012	125		Exclusive Or Test Word
013	312 ,	JZ	Jump on zero
014	300		Lo-
015	000	20 de 100	Address jumped to if zero accumulator (Hi Addr. Test Prog.)
016	303	JMP .	Jump unconditional
017	000		Lo-
020	000		Address jumped to if zero Hi accumulator

(cont.)

ADDRESS			
LOCATION (octal)	OCTAL CODE	MNEMONIC	DESCRIPTION
300	257	XRA	Exclusive Or register with A
301	062	STA	Store A direct
302	376	0111	
	-,-	E 22	Lo
303	000		Hi-/ out
304	062	STA	Store A direct
305	377		Lo-
306	000	·	Second address to be zeroed out
307	072	LDA	Load A direct
310	376		Lo
311	000		Address of data for above
312	306	ADI	Add immediate to A
313	001		Data to be added
314	062	STA	Store A direct
315	376		Lo-
316	000		Address for above to be Hi stored
317	322	JNC	Jump on no carry
320	337		Lo-
321	000		Address to be jumped to for Above
322	072	LDA	Load A direct
323	377		Lo-
324	000		Address of data for above

(cont.)

ADDRESS LOCATION (octal)	OCTAL CODE	MNEMONIC	DESCRIPTION
325	306	ADI	Add immediate to A
326	001		Data to be added
327	062	STA	Store A direct
330	377		Lo
331	000		Address for above to be stored
.332	356	XRI	Exclusive Or immediate with A
333	006		Data to be Ex-Ored
334	. 312	JZ	Jump on zero
335	000		Lo-
336	000		Address jumped to if zero Hi- accumulator
337	333	IN	Input
340	000		I/O Port Status Address
341	<i>019</i> 346	ANI	And immediate with A
342	<i>000</i> 040		Anded datamask for recieve data
343	<i>332</i> 312	JZ	Jump on zero
344	307		Lo-
345	000		Address jumped to if zero Hi- accumulator
346	333	IN	Input
347	007		I/O Port Data Address
350	356	XRI	Exclusive Or immediate with A

(cont.)

ADDRESS LOCATION (octal)	OCTAL CODE	MNEMONIC	DESCRIPTION
351	125		Data to be Ex-Ored (Test Byte)
352	312	JZ	Jump on zero
353	300		Lo-Address immed to if
354	000		Address jumped to if zero Hi— accumulator
355	303	JMP	Jump unconditional
356	000		Lo-
357	000		Jump to this address if A Hi is not zero
L			

MODEM BOARD VOLTAGE & WAVEFORM TEST DATA

 $\frac{\text{NOTE:}}{\text{All signals}}$ All signals and voltages are measured with respect to ground.

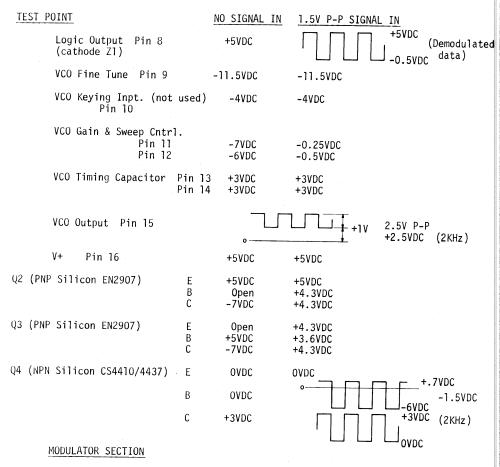
The voltage measurements were taken with a 20K ohms/V VOM.

The voltage measurements may vary $\pm 10\%$.

DEMODULATOR SECTION

Measurements on the following test points are given for both no input, and with a 1.5V P-P signal from a tape using the "Output Test Program".

TEST POINT	NO SIGNAL IN 1.5V P-P SIGNAL IN
IC A Invert. Inpt. Pin 2 uA74]	OVDC 0.15V P-P
FILTER Non-Invert. Inpt. Pin 3	OVDC
Output Pin 6	OVDC (may be ±.1V) (2KHz)
IC B Invert. Inpt. Pin 2 uA741 FILTER	OVDC 2V P-P (2Kliz)
Non-Invert. Inpt. Pin 3	OVDC
Output Pin 6	OVDC (may be ±.1V) (2KHz)
IC C XR-210 Volt. Comp. In Pin 1 (P.L.L.)	OVDC 1.2V P-P +1VDC
Phase Det. Out Pin 2	-4VDC 2.5V P-P +1VDC
Phase Det. Out Pin 3	-6.25VDC .1V P-P +1.1VDC
Phase Det. In Pin 4	-5.5VDC 2V P-P (2KHz)
Phase Det. Bias Pin 5	-5.5VDC OVDC
Phase Det. In Pin 6	-5.0VDC 1.4V P-P OVDC
V- Pin 7	-12VDC -12VDC
	(cont.) 32



Tests are made with no signal on the demodulator input. TTL logic voltage levels are used; logic 0 = -0.5v to +0.8v, logic 1 = +2v to +5.5v. The frequencies are within $\pm .05\%$ of the values listed.

TEST POINT	MODULATOR INPUT XS = LOGIC 1	MODULATOR INPUT XS = LOGIC O
IC E Pin 1 ("B" ff input) 7493 Pin 9 ("B" ff out) 4-bit ctr. Pin 8 ("C" ff out)	8900Hz-8us +pulse 4450Hz-sq. wave 2225Hz-sq. wave	8100Hz-8us +pulse 4050Hz-sq. wave 2025Hz-sq. wave

TEST_POINT	MODULATOR INPUT XS = LOGIC 1	MODULATOR INPUT XS = LOGIC O
IC G Pin 1 Output 7402 Pins 2 & 3/4 Inpt./Out. Quad 2-Inpt. Pins 5 & 6 Input NOR Pin 11 Input Pin 12 Input Pin 13 Output	2MHz sq. wave	inhibit pin 13)
IC H Pin 1 Input 7420 Pin 2 Input Dual Quad Pin 4 Input Inpt. NAND Pin 5 Input Pin 6 Output Pin 13 Input Pin 12 Input Pin 10 Input Pin 9 Input Pin 8 Output	8900Hz-8us +pulse 500KHz-sq. wave 250KHz-sq. wave 125KHz-sq. wave 2225Hz-500ns -pulse +5VDC +5VDC 2225Hz-sq. wave 2225Hz-sq. wave 2225Hz-sq. wave	8100Hz-8us +pulse 500KHz-sq. wave 250KHz-sq. wave 125KHz-sq. wave 2025Hz-500ns -pulse +5VDC +5VDC 2225Hz-sq. wave 2225Hz-sq. wave 2225Hz-sq. wave
IC J Pin 2 Clock Inpt. 9316/74161 Pin 15 Ripple Carry Out. Presettable 4-bit ctr.	2MHz 125KHz-50Ons +pulse	2MHz 125KHz-500ns +pulse
IC K Pin 2 Clock Inpt. 9316/74161 Pin 15 Ripple Carry Out. Presettable 4-bit ctr.	2MHz 8900Hz-8us +pulse	2MHz 8100Hz-8us +pulse